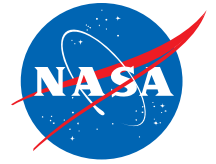
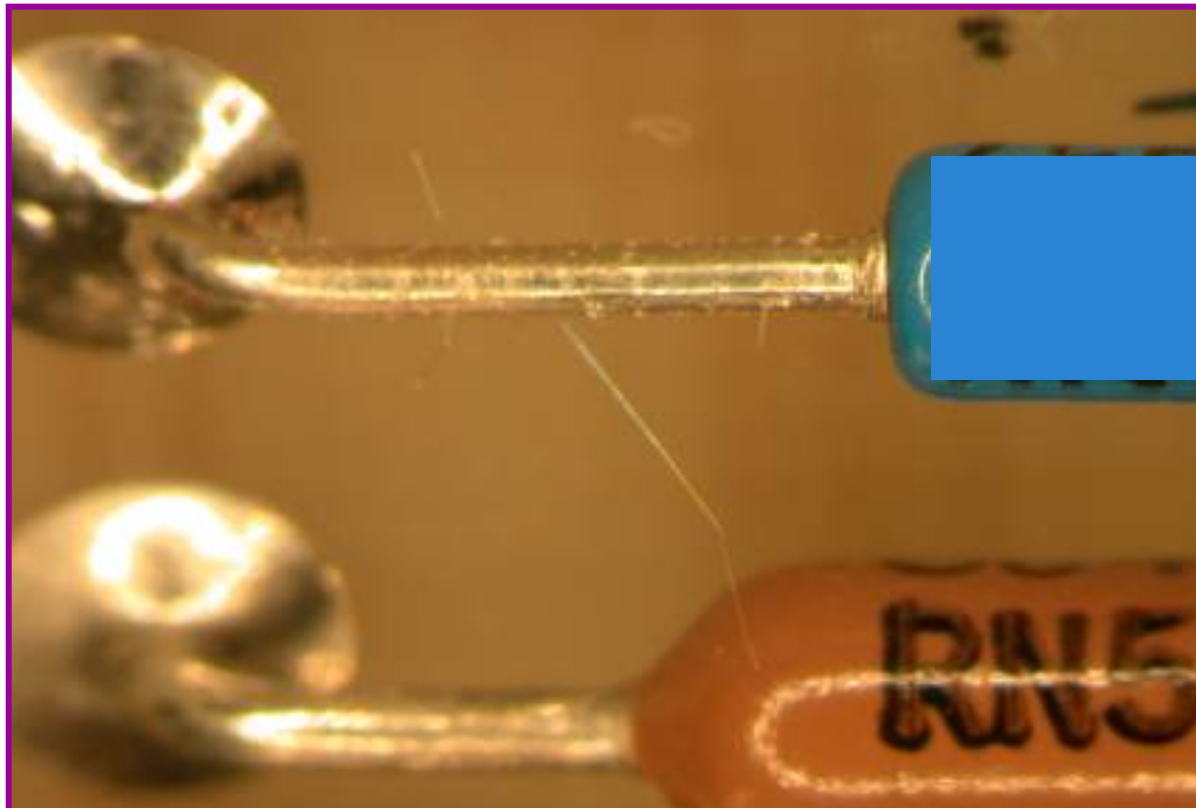


Metal Whiskers



Discussion for the Nuclear Procurement Issues Committee
(NUPIC)



Jay Brusse / Perot Systems

<http://nepp.nasa.gov/whisker>

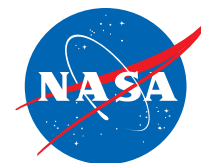
Dr. Henning Leidecker / NASA Goddard

Lyudmyla Panashchenko / Univ. of MD-CALCE Graduate Student

June 19, 2008

Nuclear Procurement Issues
Committee (NUPIC) Meeting

1



Outline

- A Brief History of Metal Whiskers
- System Failure Modes Caused by Metal Whiskers
- Inspection Tips
- A Few Mitigation Strategies to Reduce Harm From Metal Whiskers

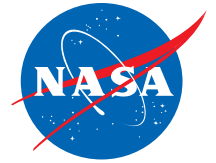


**Zinc Whiskers on
Hot Dip Galvanized Steel Pipe**

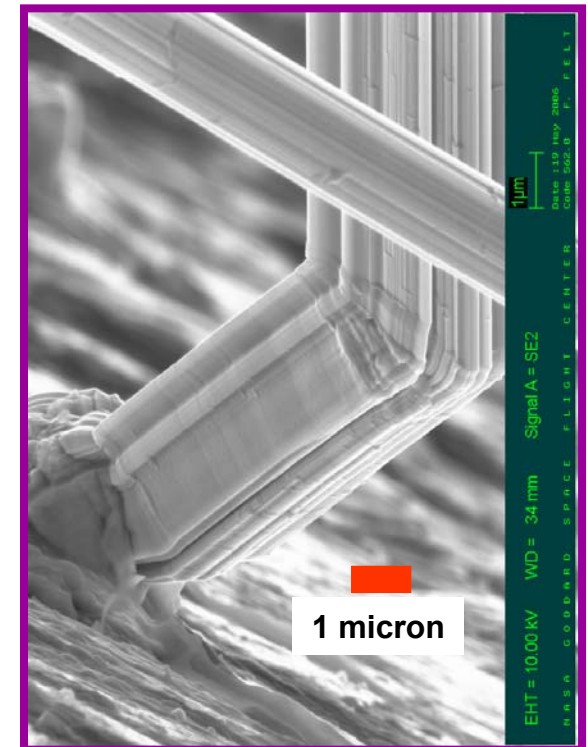
**Cover Photo:
Tin whiskers on Tin-Plated Diode Terminals
(Courtesy Ted Riccio - STPNOC)**

- ***NO WHISKER GROWTH THEORY TO BE DISCUSSED!!!***

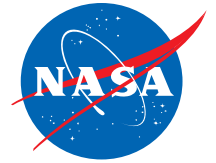
What are Tin or Zinc or Cadmium Whiskers?



- **DESCRIPTION:**
 - Hair-like, metallic crystals that **UNPREDICTABLY** sometimes grow out from a metal surface
 - Straight or kinked filaments, nodules, odd-shaped eruptions
 - Filaments usually have uniform cross section along entire length
 - Tin, Zinc and Cadmium coatings are most common sources
 - Whiskers are also less frequently seen on metals like Indium, Gold, Silver, Lead, and other metals
- **GROWTH TIMELINE:**
 - Incubation: Absence of growth may last from hours to years
 - Growth: Accretion of metal ions at base of whisker **NOT** at tip
 - Rate of Growth: < 1 mm/yr (typical)
Highly variable (up to 9mm/yr reported)
- **LENGTH:** ~1mm or less (typical)
Rarely up to 10 mm or more
Log-normally distributed
- **THICKNESS:** A few microns (typical)
Range 0.006 to >10 μm
10 to >100 times thinner than a human hair!!!



*Tin Whiskers on Tin-Plated
Electromagnetic Relay Terminals*



The Good News:

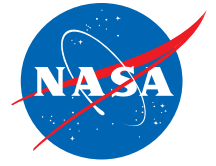
Not All Tin, Zinc or Cadmium Surfaces
Will Grow Whiskers

(See Back Up Slide for Discussion)

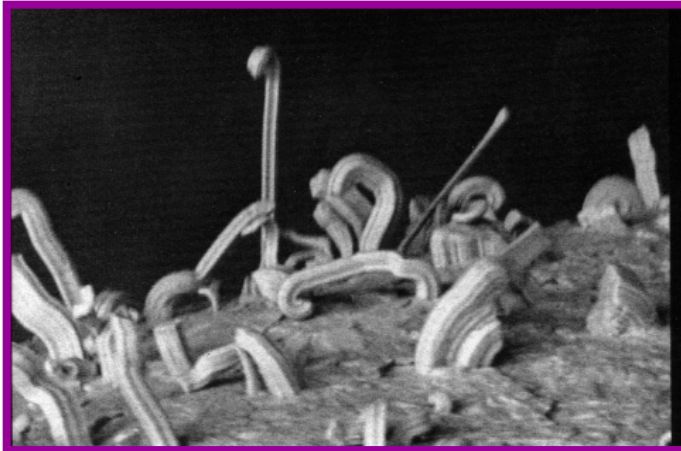
The Bad News:

Current theories and test methods DO NOT
Enable prediction of the time-dependence of
Population Density, Length, Thickness

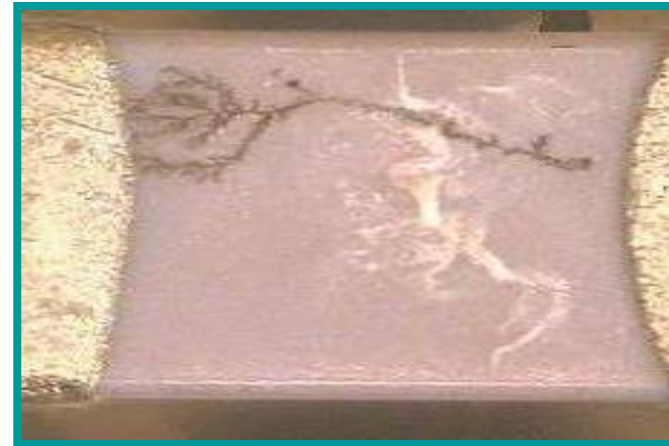
A useful theory should identify what we must
control to make confident predictions.
Such a theory has remained elusive



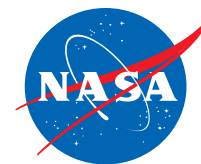
“Whiskers” are NOT “Dendrites”



- Whisker Growth is
 - Filament-like, rarely branching
 - Outward/Away from surface
- Whisker Growth **Does NOT** Require
 - Solvents
 - Electric Fields
 - Moisture, Elevated temperature, T-Cycle



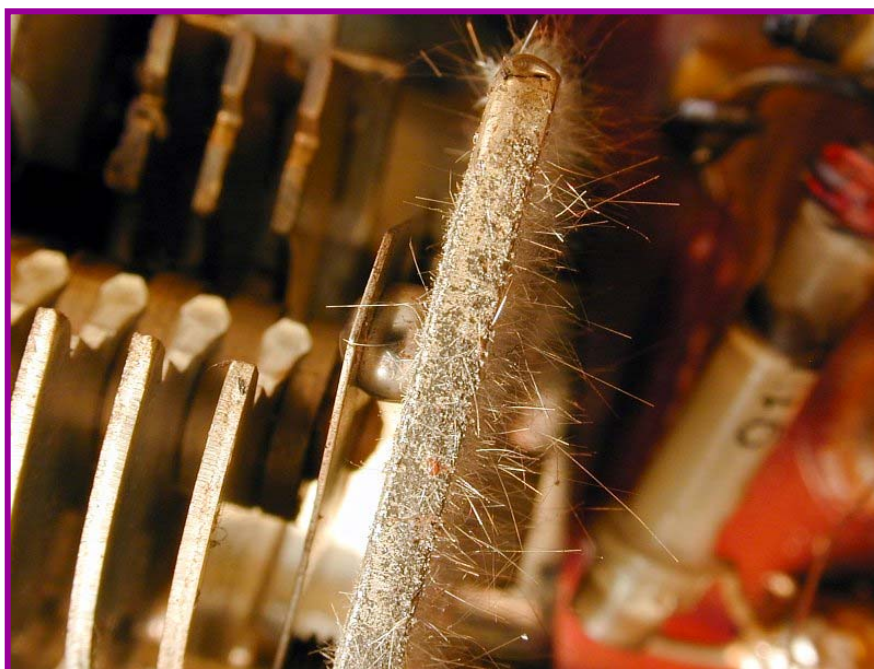
- Dendrite Growth is
 - Fern-like, branching
 - Along a surface
- Dendrite Growth **DOES** Require
 - Solvents to dissolve the metal into ionic species
 - Electric Fields to cause ion migration



Metal Whiskers

“The Early Years”

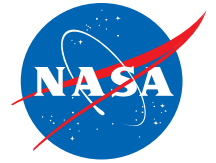
- **1946: Cadmium Whiskers**
H. Cobb (Aircraft Radio Corp.) publishes earliest “known” account of **CADMIUM** whiskers on cadmium-coated variable air capacitor plates. Whiskers induced electrical shorting in military equipment. These events occurred during WW II (~1942 – 1943)
- **1952: Tin and Zinc Whiskers**
Since Cadmium coatings resulted in shorting, Tin and Zinc were used instead. But then K.G. Compton, A. Mendizza, and S.M. Arnold (Bell Labs) reported shorting caused by whiskers from these coatings too!



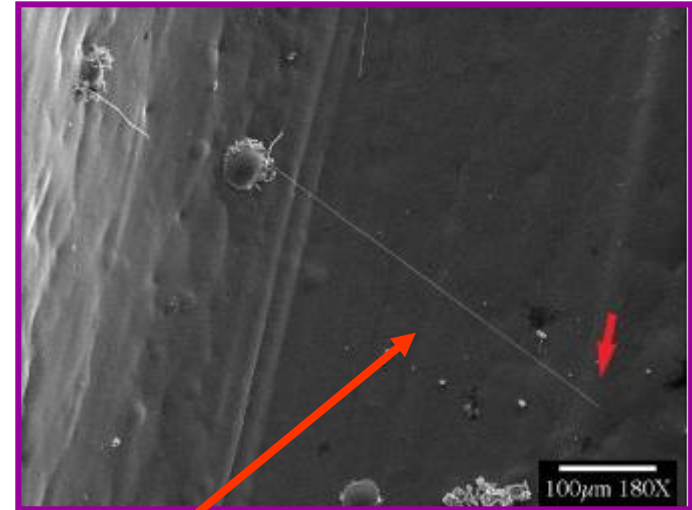
*Tin Whiskers on 1960's Era
Variable Air Capacitor*

Whisker Resistant Metal Coatings

“The Quest”



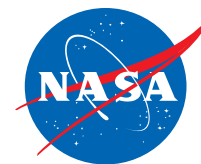
- 1950s and 60’s [1] [2]:
Bell Labs worked through the periodic table to determine whether addition of some element to a Tin coating would “inhibit” whiskering
 - **Adding 0.5 - 1% (by weight) or more of Lead (Pb) into tin inhibits whiskering**
 - **Alloying with metals other than Pb sometimes ENHANCES whiskering**
- Since 1990s:
To inhibit whiskers most US MIL specs require adding Pb to tin coatings used near electronics
 - For design margin, the concentration is usually named as 2% to 3% Pb by weight
 - However, international legislation that restricts use of Pb in consumer electronics is affecting availability of “Pb” bearing tin coatings
- What additives quench Zn & Cd whiskers?
 - We don’t know, but certainly NOT chromate conversion finishes!



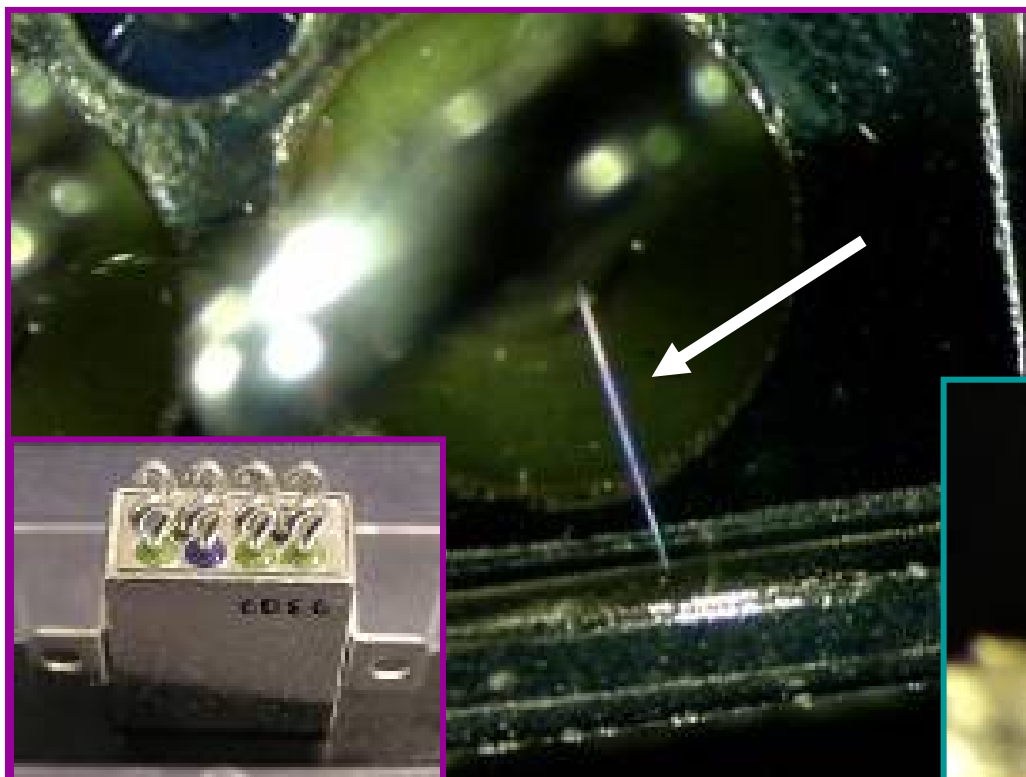
*Zinc Whiskers Growing from
Zinc-Plated Yellow Chromate Steel Bus Rail*

[1] S. Arnold, "Repressing the Growth of Tin Whiskers," *Plating*, vol. 53, pp. 96-99, 1966

[2] P. Key, "Surface Morphology of Whisker Crystals of Tin, Zinc and Cadmium," *IEEE Electronic Components Conference*, pp. 155-160, May, 1970

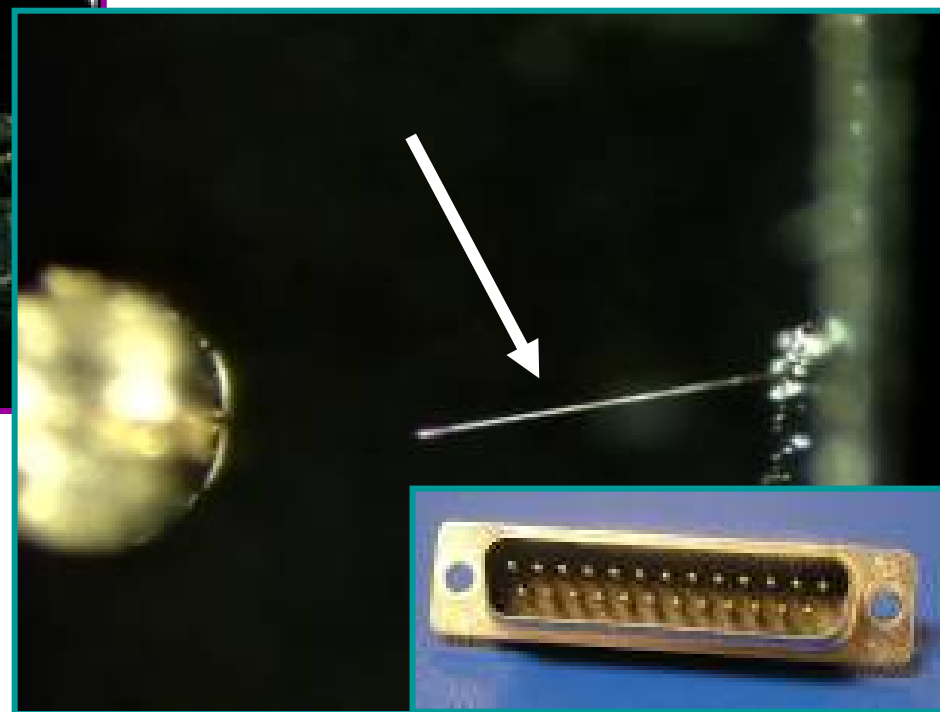


Examples of Metal Whiskers

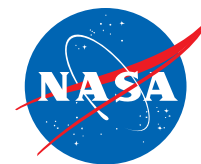


***Tin Plated Electromagnetic Relay
Tin Whisker Shorting
Terminals and Case***

***Tin-Plated D-Sub Connector Shell
Advertised as "RoHS Compliant"***



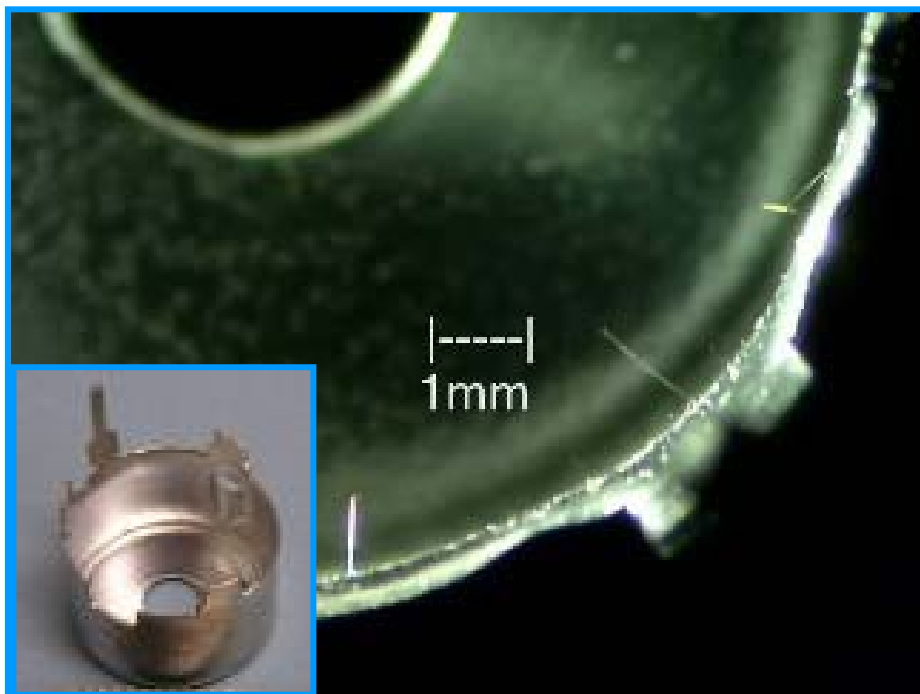
NOTE: Procurement Spec PROHIBITED Tin-Plating!



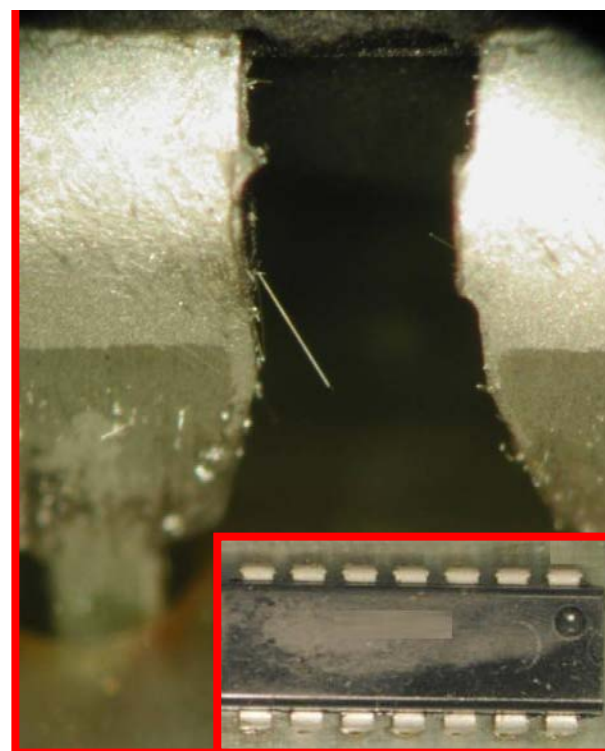
Examples of Metal Whiskers

Tin-Plated Transformer Can Tin Whiskers “As Received”

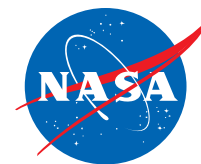
***Note: Supplier Changed to Pure Tin
WITHOUT Warning Customers***



Tin-Plated DIP IC Leads Tin Whiskers Produce Field Failure in Power Plant After 20 Years in Field!

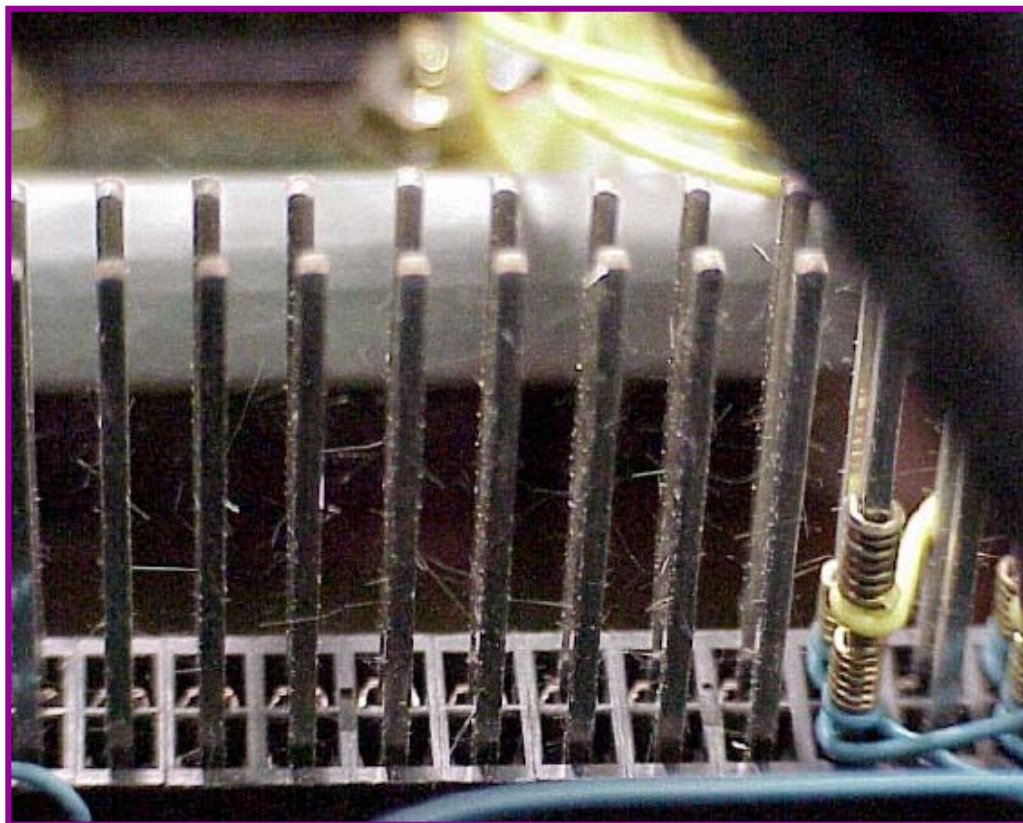


<http://nepp.nasa.gov/whisker/anecdote/20year>



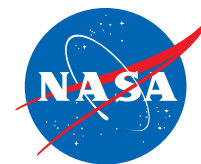
Examples of Metal Whiskers

*Tin-Plated Wire Wrap Pins
Tin Whiskers*

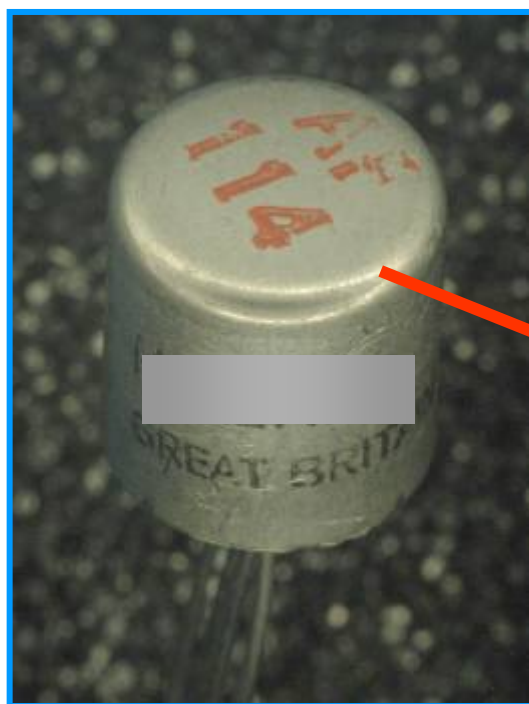


GE Power Management, "Technical Service Bulletin: Tin Whiskers in MOD10 Relays", March 27, 2000

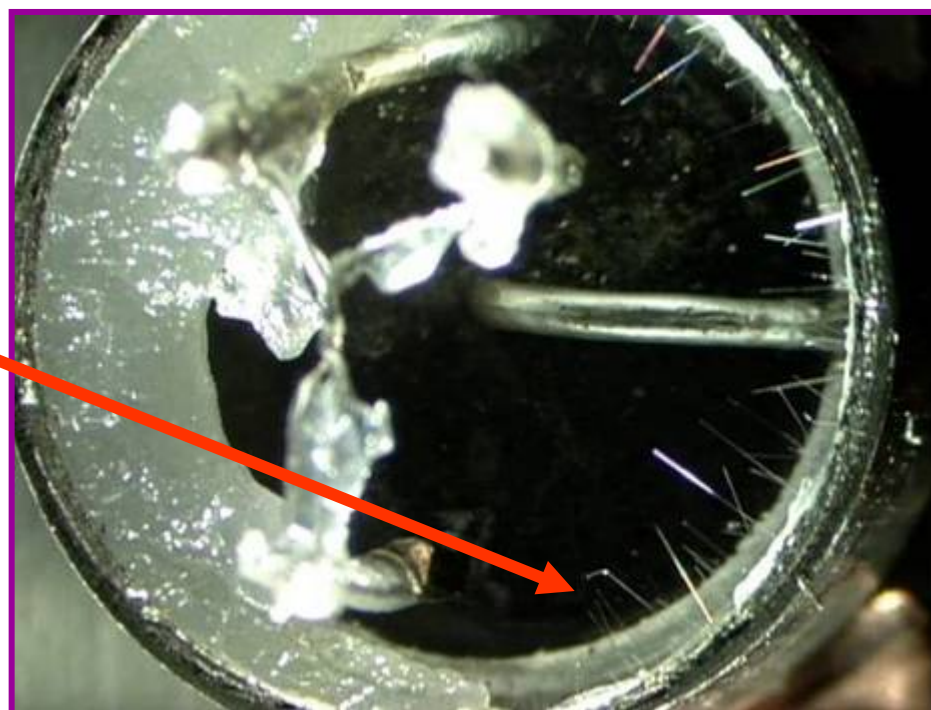
<http://www.geindustrial.com/pm/support/dls/dlssb01.pdf>



Guess What's Lurking Inside?



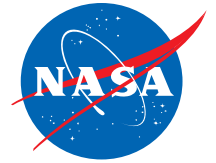
**1960's Vintage
Transistor**



Transistor Package is Tin-Plated Inside.

**Many Radio Malfunctions Have Been Attributed
to Whiskers Shorting Case to Terminals**

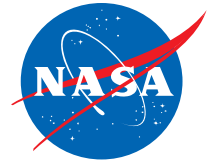
<http://www.vintage-radio.net/forum/showthread.php?t=5058>



*“There is a name for those who suppose that doing the same thing will produce different results. That name is ‘**Idiot**’.”*

- Albert Einstein

Some Metal Whisker Experiences In the Power Industry



Date	Location	Event
1987	Dresden Nuclear	Trip of "B" Channel of RPS
1990	Duane Arnold	Reactor Scram
1995	Duane Arnold	Reactor Scram/Controlled Shutdown
1997	Dresden Nuclear	Reactor Scram
1999	South Texas Project	Reactor Pre-Trip Alarm
2005	Dominion Millstone	Reactor Trip

Source: "A Prioritization of Generic Safety Issues (NUREG-0933): Issue 200 – Tin Whiskers", U.S. Nuclear Regulatory Commission, Sept. 2007
<http://www.nrc.gov/reading-rm/doc-collections/nuregs/staff/sr0933/sec3/200.html>

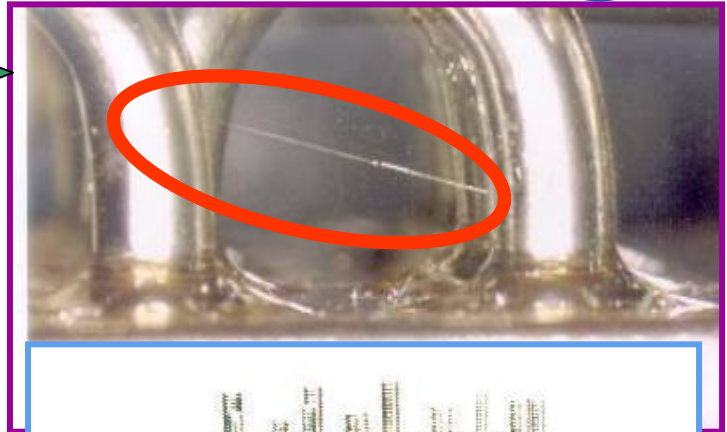
Date	Location	Source	Event
1995	Not Specified	Priv. Comm.	Tin Whiskers in Relays
1999 [1]	Foreign Plant	Foxboro	Tin Whiskers in Relays → 3 False Alarms/Plant Shutdown
2001 [2]	Foreign Plant	Anonymous	Tin Whiskers on IC leads → Reactor Trip
2002 [3]	Not Specified	Westinghouse	Whiskers on Potentiometers → Power Supply Failures
2006	Not Specified	Priv. Comm.	Zinc Whiskers in Relays
2006	Not Specified	Priv. Comm.	Tin Whiskers in Relays

[1] http://nepp.nasa.gov/whisker/reference/tech_papers/stevens2001-relay-failures-induced-by-tin-whiskers.pdf
 [2] <http://nepp.nasa.gov/whisker/anecdote/20year>
 [3] http://nepp.nasa.gov/whisker/reference/tech_papers/2002-westinghouse-tb02005.pdf

Basic Whisker Failure Modes

Electrical Short Circuits

- Continuous short if current $I_{whisker} < I_{melt}$
- Intermittent short if $I_{whisker} > I_{melt}$
- **Metal Vapor Arc!!!** See Discussion
Up to HUNDREDS of AMPERES can be Sustained!!!



Debris/Contamination

- Dislodged whiskers become foreign object debris
 - Produce Shorts in Areas REMOTE From Whisker Origins
(Zinc Whiskers on raised flooring are a PRIME Example-
Please See Backup Slide)
 - Interfere with Sensitive Optics or Micro-Electro-Mechanical Systems (MEMS)





Metal Whisker Melting Current -- Pt. 1

$$I_{melt,vac} = \left[\frac{2\sqrt{LzT_0}}{R_0} \right] \cos^{-1} \left(\frac{T_0}{T_{melt}} \right)$$

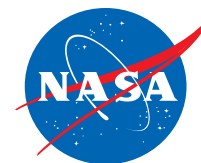
See Backup Slides for Derivation

- Where $Lz \sim 2.45 \cdot 10^{-8} (V/K)^2$ is the Lorenz number, T_{melt} = melting temperature, T_0 = ambient temperature, R_0 = whisker resistance at ambient

Material	T_{melt}	$I_{melt, vac}$	$V_{melt} = R_0 * I_{melt, vac}$
Tin	505.1K	87.5 mV / R_0	88 mV
Cadmium	594.2K	97.1 mV / R_0	97 mV
Zinc	692.7K	104.4 mV / R_0	104 mV

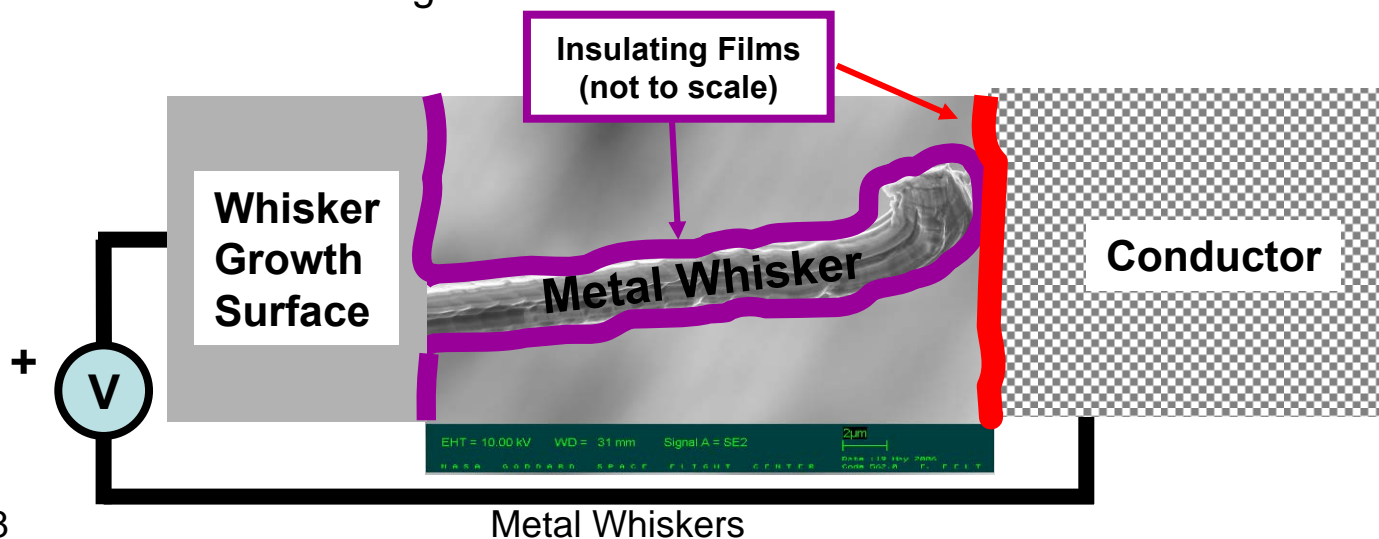
***If $V_{whisker} > V_{melt}$
Then the Whisker will Fuse Open***

But there is MORE to this story

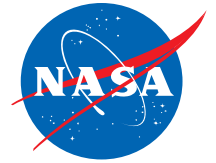


Metal Whisker Melting Current -- Pt. 2

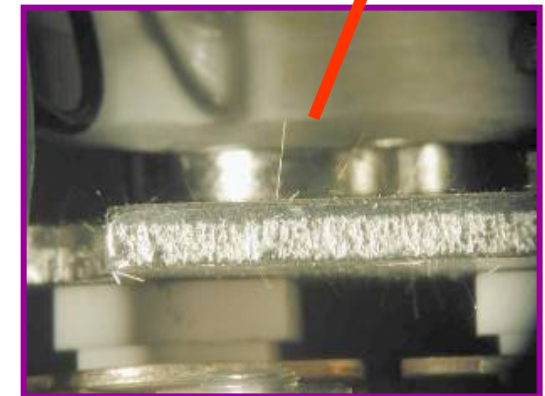
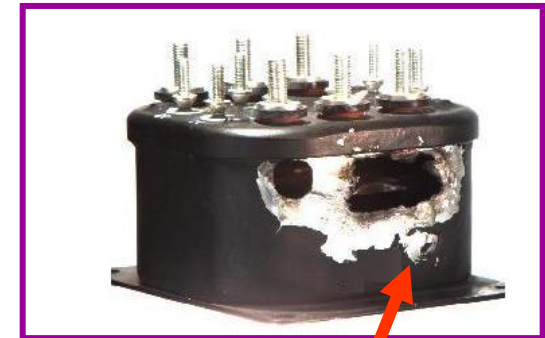
- Electrically insulating films naturally form on metal surfaces INCLUDING surfaces of metal whiskers
 - Examples: oxides, hydroxides, sulfides, moisture films, etc.
- Direct **MECHANICAL** contact by the whisker to another conductor does NOT guarantee **ELECTRICAL** contact
 - For Electrical Contact, the potential difference must exceed “dielectric breakdown” of the insulating films
 - For tin and zinc whiskers, independent groups have confirmed the film breakdown can range from $\sim 0.2V$ to $\sim 45V$



Sustained Metal Vapor Arcing Initiated by Metal Whisker

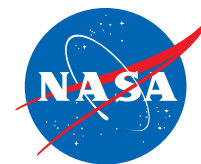


- When a metal whisker shorts two conductors at different potentials, a sustained arc can occur if
 - Current is high enough to vaporize the whisker (i.e., metal gas)
 - Voltage is high enough to ionize the metal gas
- Sustained arcing between metal conductors is possible for voltages as low as ~12 to 14 volts when
 - Arc gap is **SMALL** ~ a few tens of microns
 - Available current > ~100 to 300 mA
 - See “Electrical Contacts - Part III” by Paul G. Slade
- However, as arc gap increases, sustaining the arc requires
 - Higher voltage to ionize the metal gas
 - Higher current to boil enough additional metal gas to keep plasma dense enough to sustain it
 - Vacuum (i.e., low pressure) is NOT required, but can reduce the threshold voltage and current required for arcing
- Relevant metal vapor arc testing by NASA of FM08 style fuses with metal filaments ~5 mm long
 - ~75 volts at more than 30 amperes is needed to generate a sustained arc across this arc gap when P ~1 torr



Tin Whiskers Growing on Armature Of Relay Produced Metal Vapor Arc

G. Davy, "[Relay Failure Caused by Tin Whiskers](http://nepp.nasa.gov/whisker/reference/tech_papers/davy2002-relay-failure-caused-by-tin-whiskers.pdf)", Northrop Grumman, Technical Article, October 2002
http://nepp.nasa.gov/whisker/reference/tech_papers/davy2002-relay-failure-caused-by-tin-whiskers.pdf



How do YOU Relieve the “Stress” from Whiskers?

Option A

Man with Facial Whiskers Does Yoga

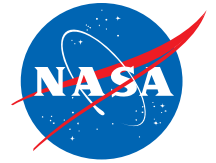


Option B

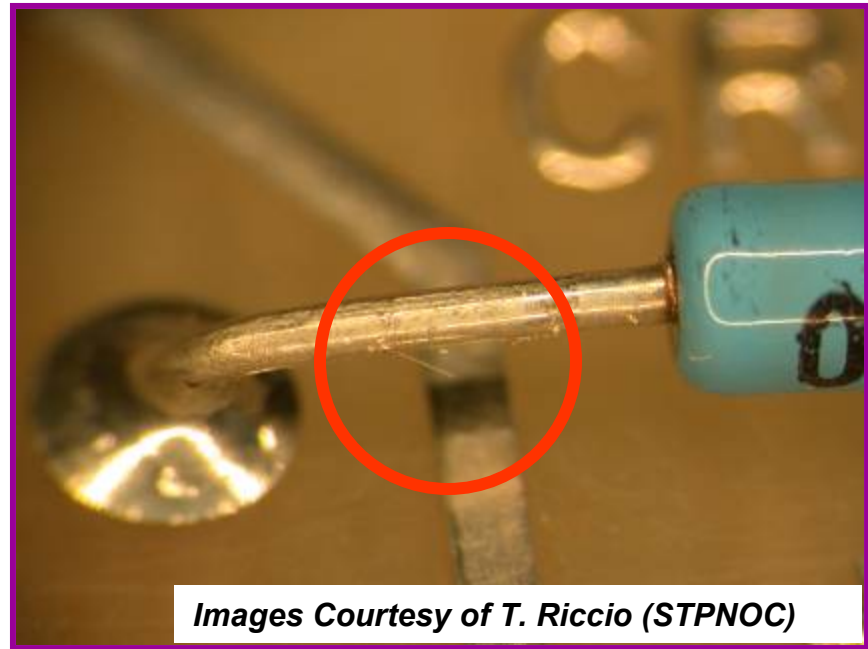
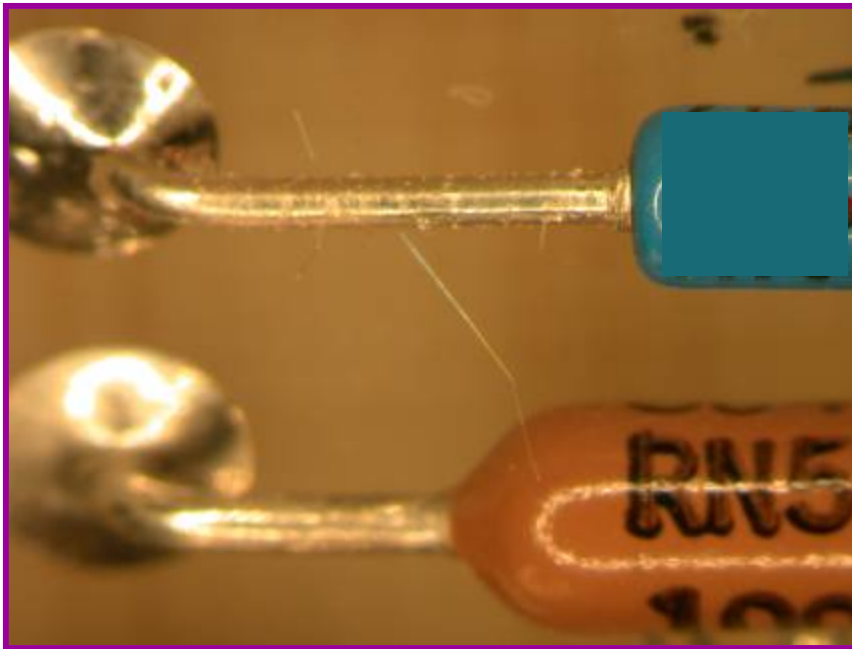
Men with Metal Whiskers Use “Innovative” Techniques



A Case for Whisker Mitigation Strategies?



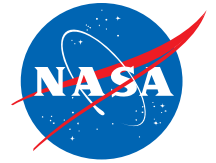
Tin Whiskers on Tin-Plated Axial Leaded Diodes



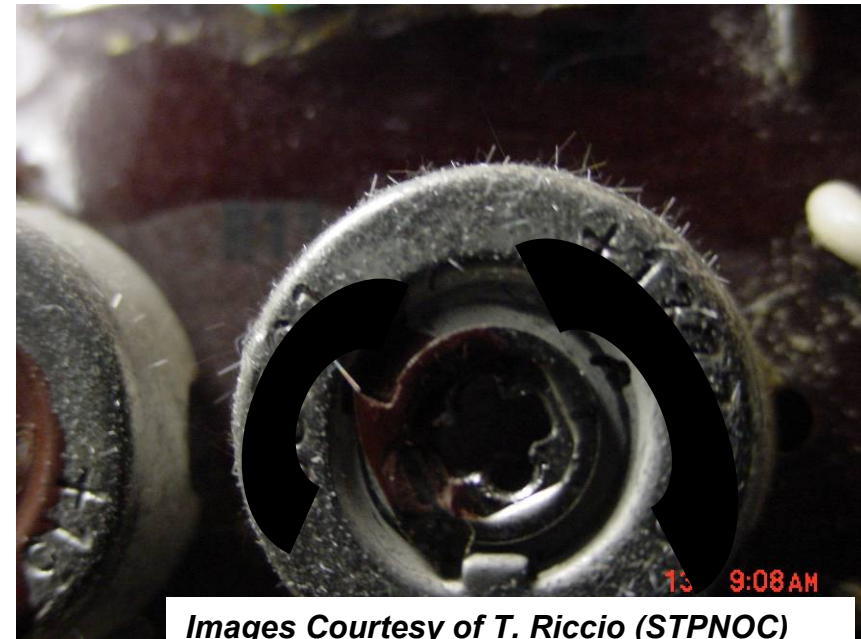
Images Courtesy of T. Riccio (STPNOC)

- Diode Leads were **NOT Hot Solder Dipped** prior to assembly; thus leaving large surface area of pure tin coating prone to whisker growth
- PWB and components were **NOT Conformal Coated**; thus leaving adjacent conductors exposed to bridging by whisker growth

Another Case for Whisker Mitigation Strategies?



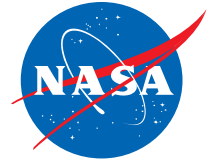
Metal Whiskers on External Case of Potentiometers



Images Courtesy of T. Riccio (STPNOC)

- No electrically insulating materials were used on the metal cases
- Metal whiskers bridging between the cases or from case to adjacent components can cause circuit malfunction

Three Whisker Mitigation Strategies



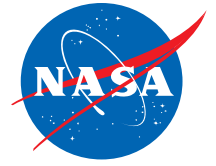
Mitigation – to make less severe or painful

Merriam-Webster Dictionary

Risk “Mitigation” \neq Risk “Elimination”

- Avoid Use of Whisker Prone Surface Finishes
 - *“Trust, But VERIFY” Certificates of Conformance!*
 - Perform independent materials composition analysis using X-ray Fluorescence (XRF), Energy Dispersive X-ray Spectroscopy (EDS), etc.
- Conformal Coat - Electrically Insulating Barriers
 - Benefit #1: When applied on top of a whisker prone surface, conformal coat can sometimes keep whiskers from pushing through
 - Benefit #2: When applied to a distant conductor, can block whiskers from electrically shunting distant conductors
 - Benefit #3: Provides insulating barrier against loose conductive debris
- Remove/Replace Tin Finishes When Practical
 - Hot Solder Dip using lead-tin (Pb-Sn) solders
 - “First, Do No Harm” Principle

NASA Goddard Whisker Mitigation Study Conformal Coat (Uralane 5750* Polyurethane) ~9 Years of Office Ambient Storage



- **Specimens:**

- 1" x 4" x 1/16" Brass 260
- Tin-Plated 200 microinches
- A few intentional scratches created after plating to induce localized whisker growth

- **Conformal Coating:**

- Uralane 5750 on 1/2 of sample
- Nominal Thickness = 2 mils
- Locally THIN Regions also examined

- **Storage Conditions:**

- Office Ambient ~ 9 years

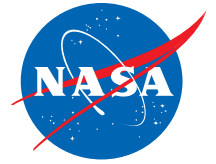


* Uralane™ 5750 now known as Arathane™ 5750

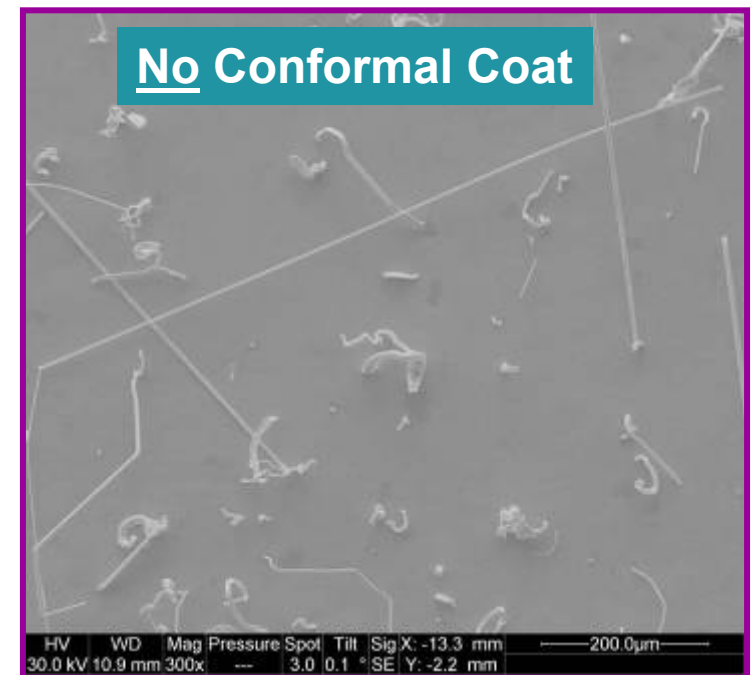
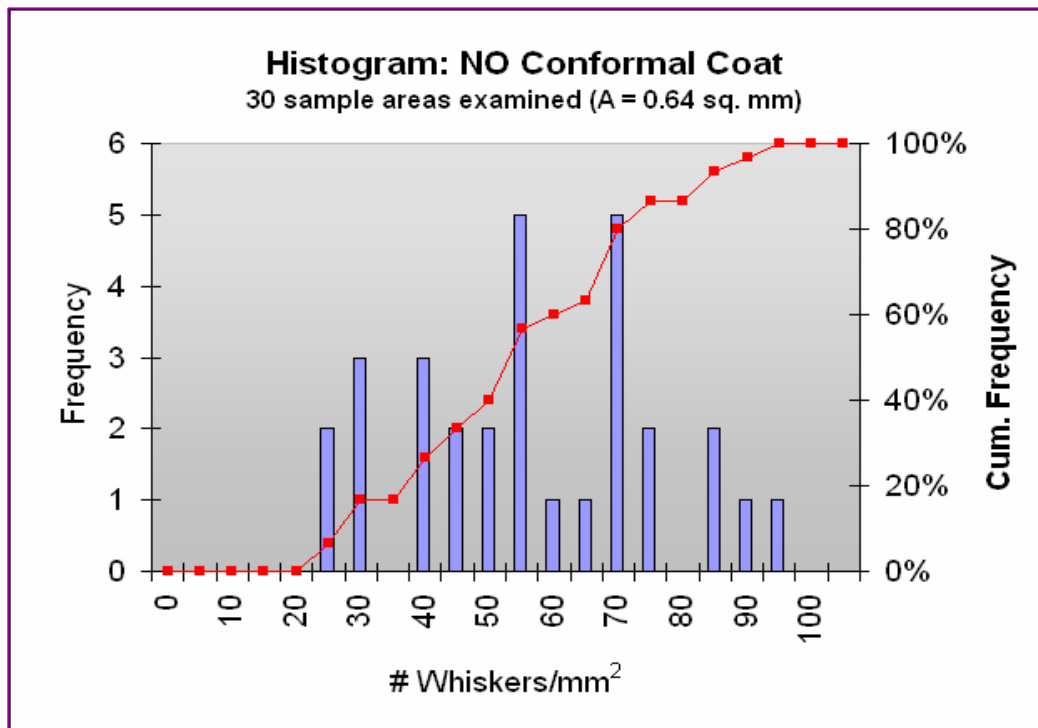
NASA Goddard Whisker Mitigation Study

Control Areas – No Conformal Coat

9-Years of Office Ambient Storage



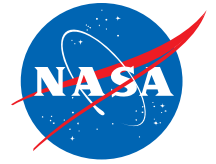
- Control Areas Grew Whiskers Abundantly within the First Year. After 9 years of storage we found the following:
 - 30 areas each 0.64 mm² were randomly examined for whisker density
 - Avg: 55 ± 19.6 whiskers / mm²
 - Range: 23 to 95 whiskers / mm²



NASA Goddard Whisker Mitigation Study

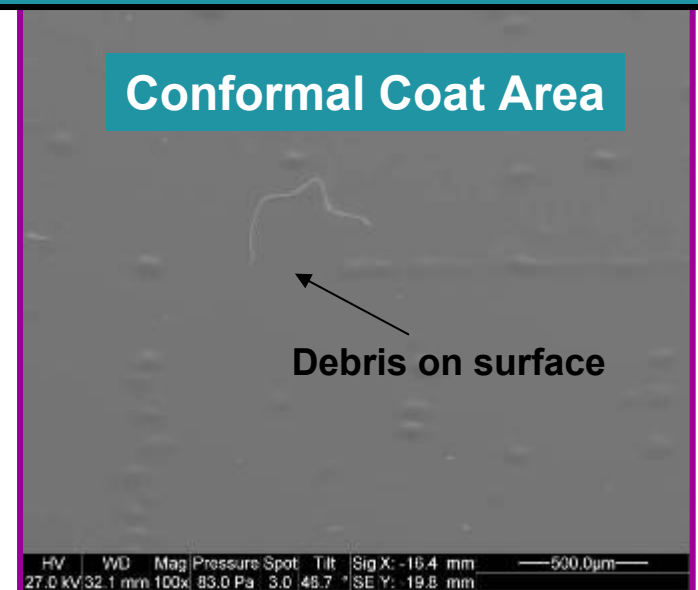
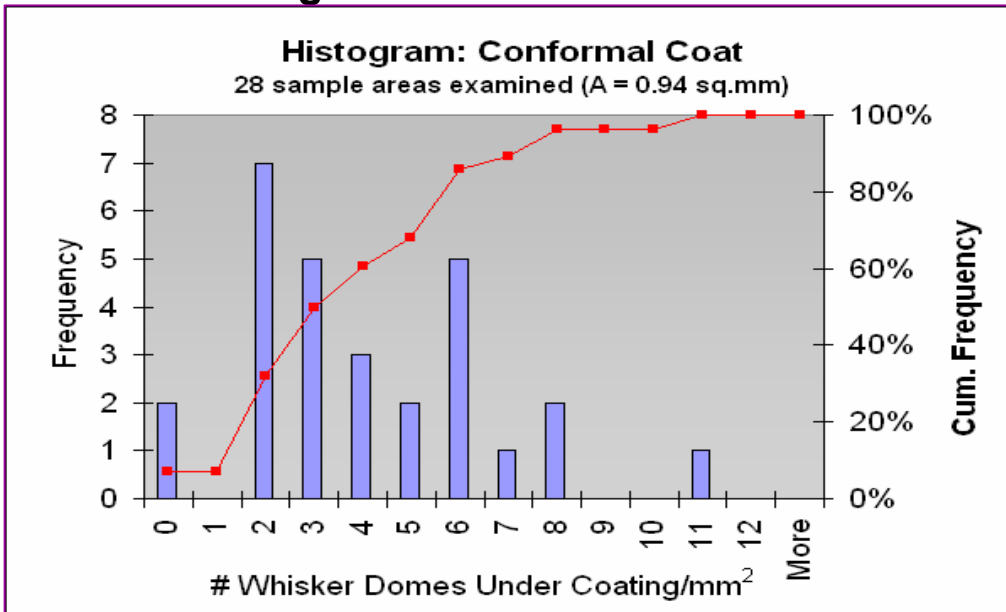
Uralane 5750 – 2 Mils Thick

9-Years of Office Ambient Storage



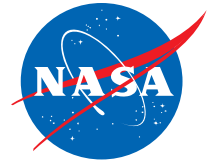
- Conformal Coated Areas Grew Whiskers Too within the First Year. After 9 years of storage we find the following:
 - *To date ALL whiskers are contained beneath the coating that is 2 mils thick*
 - *SEM cannot see INTO coating. Thus we see only “domes” caused by whiskers that lift coating slightly*
 - Avg: 3.4 ± 2.6 domes / mm²
 - Range: 0 to 10.6 domes / mm²

We suspect we are only counting “thick” whiskers in this statistic because the “thin” ones mechanically buckle before they can lift the coating enough to produce visible “domes”

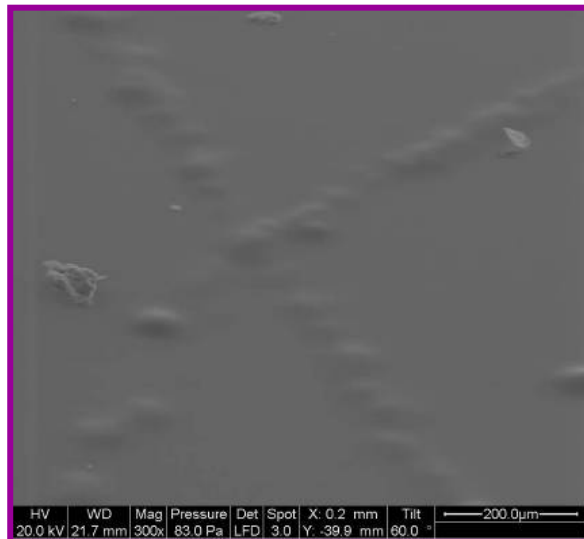


NASA Goddard Whisker Mitigation Study

Uralane 5750 Conformal Coat - 9-Years of Office Ambient Storage

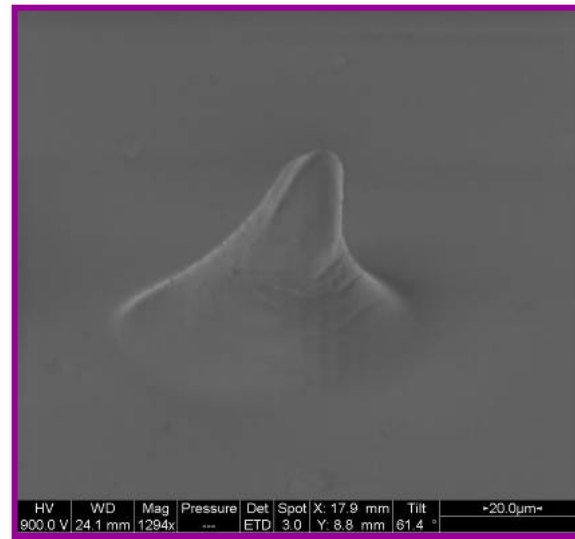


**2 Mils Uralane =
Very Effective**



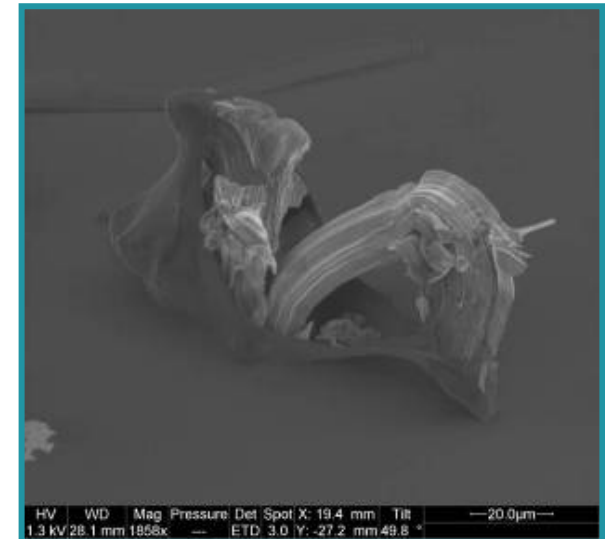
**Whiskers Completely
Entrapped Under the
Coating → Euler Buckling**

**~0.5 Mils Uralane =
Less Effective**

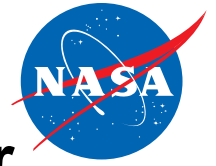


**Whisker “Lifting” Coating
into Shape of Circus Tent,
But Not Yet Penetrating**

**~0.1 Mils Uralane =
Not Effective**



**Whiskers Breaking
Through
“Thin” Coating**

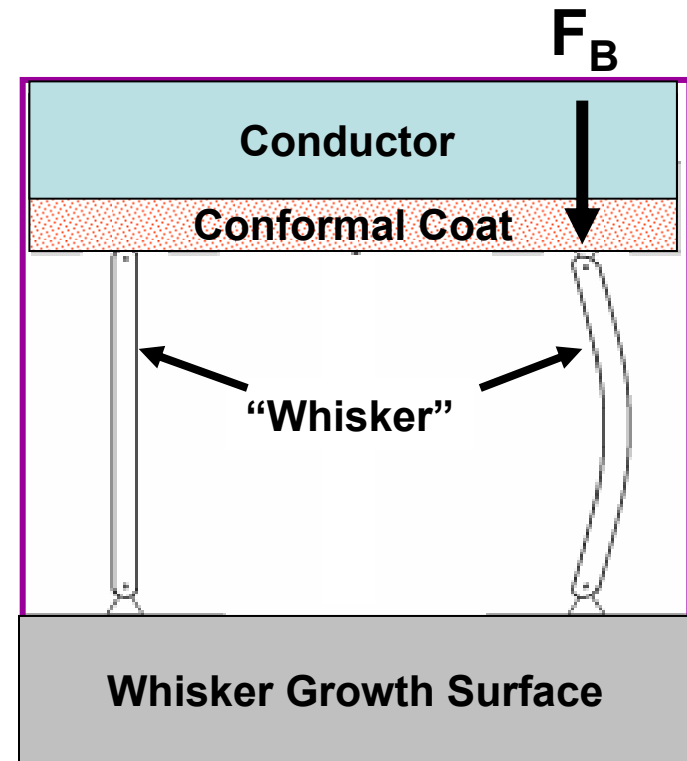


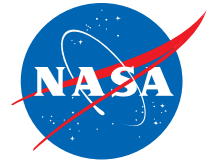
Euler Buckling

Axial Force Required to Buckle a Metal Whisker

$$F_B = \frac{\pi^2 EI}{(KL)^2} \approx \left(\frac{\pi^3 \cdot E}{32} \right) \left(\frac{d^4}{L^2} \right)$$

E = Young's Modulus of whisker material,
I = Area Moment of Inertia,
(e.g. $I = \pi d^4 / 64$ for circular cross section)
L = Length of whisker,
K = Column Effective Length Factor
K = 0.5 for whisker fixed at both ends
K = 0.7 for fixed at one end, pinned at other

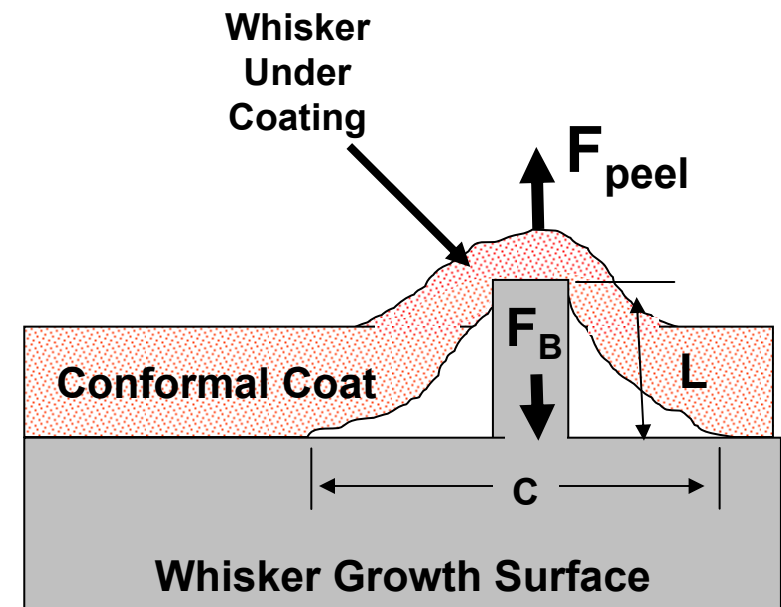




Whiskers Lift and Peel Conformal Coat Until Whisker Buckles OR Coating Fails

(F_{peel} vs. F_{Buckle})

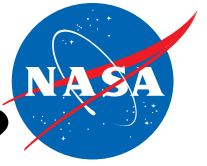
- As whisker first emerges it is short and stiff thus $F_B > F_{\text{peel}}$ and whisker begins to lift the coating forming a “circus tent” with height $L =$ length of whisker;
- “Tent” joins the surface at a circle of circumference $C \sim 2\pi QL$,
 - Q describes the details of tent-like shape
- To peel conformal coating up and away from the surface, one needs to apply a force (F_{peel}) proportional to the circumference:
 - $F_{\text{peel}} = \Phi * C = 2 \pi Q \Phi L$
 $\Phi =$ peel strength of material which describes the adhesion of the coating to the tin, and the effect of the separation angle. It also depends on the rate at which the coating is peeled away.



Uralane 5750 has better self-cohesion than adhesion to a tin surface

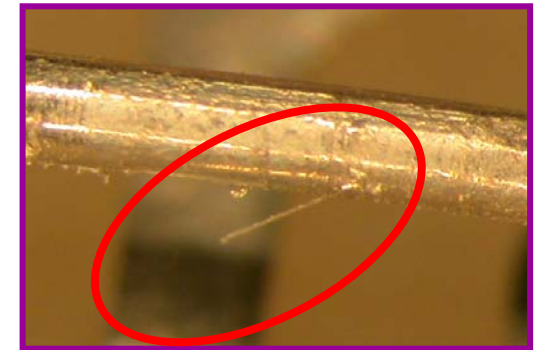
Additional Analysis Pending

Will Whiskers Buckle Before Puncturing the Coating on a Distant Surface?



- The displacement of the conformal coat due to a whisker pushing against the coating is:

$$D = \left(\frac{1 - \nu^2}{E_{coat}} \right) \left(\frac{F_B}{d} \right) \approx \left(\frac{\pi^3}{32} \right) (1 - \nu^2) \left(\frac{E_W}{E_{coat}} \right) \left(\frac{d^3}{L^2} \right)$$



Where

D = Displacement of conformal coat

ν = Poisson's ratio

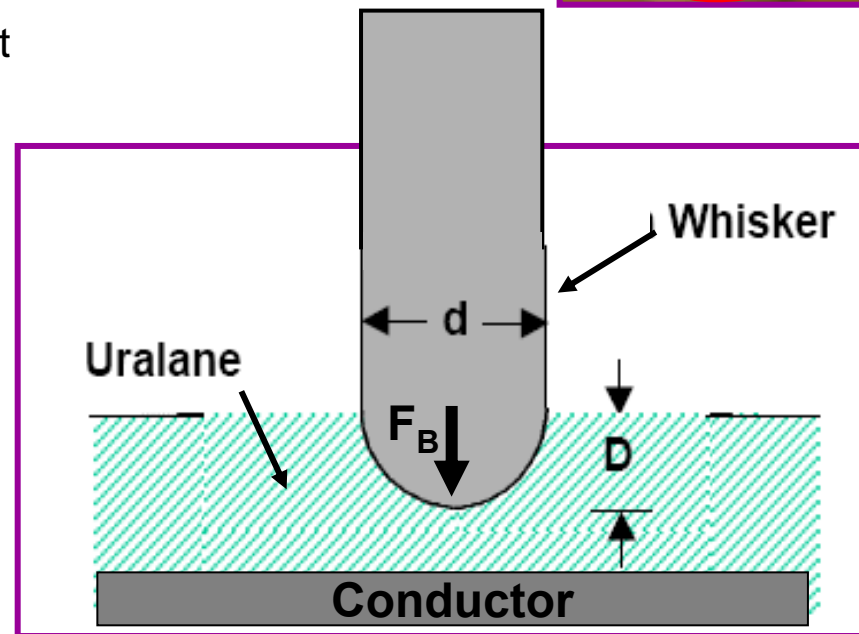
E_{coat} = Young's Modulus of coating

E_W = Young's Modulus of Whisker

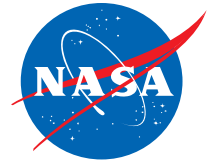
d = "Diameter" of whisker

L = Length of whisker

F_B = Euler Buckling Strength of the whisker

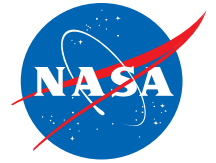


Effects of Conformal Coating -- 1

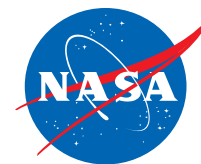


- Numerous sorts of coatings have been tried:
 - Reports of success vary from “none” to “perfect”, sometimes for the same sort of coating.
- NASA GSFC has used Uralane 5750, applied to pre-primed tin-plated surfaces to a thickness of 2 mils (=50 micrometers) +/- 10%:
 - After ~9 years of office ambient storage, these surfaces have whiskered abundantly, but the number of whiskers escaping through the 2 mil thick areas has been zero
- Dr. Thomas Woodrow (Boeing) has studied Urethane (acrylic) coatings, a silicone coating, and Parylene C coating of varying thicknesses up to ~ 4 mils (= 100 micrometers):
 - Some whiskers have penetrated even the thickest coatings when exposed to 25°C / 97% R.H.
 - "Evaluation of Conformal Coatings as a Tin Whisker Mitigation Strategy, Part 2", T. Woodrow, SMTAI, Sept. 2006
http://nepp.nasa.gov/whisker/reference/tech_papers/2006-Woodrow-Conformal-Coating-PartII.pdf

Effects of Conformal Coating -- 2



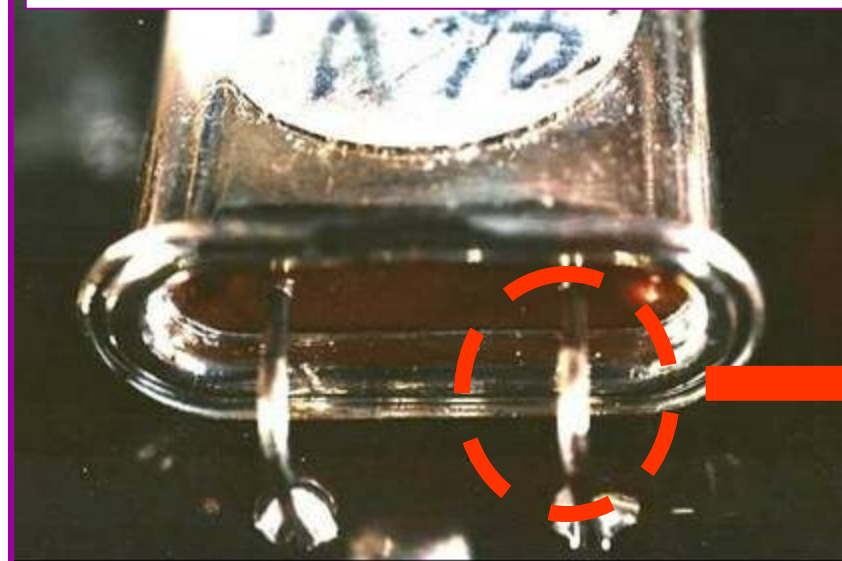
- Conclusion 1: *2 mils Uralane 5750 Provides Substantial Protection*
 - Uralane 5750, applied to at least 2 mils thickness, is a substantial improvement over an uncoated surface.
- Conclusion 2: *Understand YOUR Conformal Coating Processes*
 - Conformal coating processes can leave “weak zones” with less than the nominal thickness of coating.
 - Areas shadowed during application
 - Coating flows/thins prior to cure
 - Thinner coatings are more prone to whisker puncture
- Conclusion 3: *Even “Poor” Coatings Can Offer Some Protection*
 - Long whiskers bend easily (Euler Buckling) and are less likely to penetrate even thin conformal coat.
 - Conformal coat protects against a conductive bridge from detached whiskers lying across a pair of coated conductors



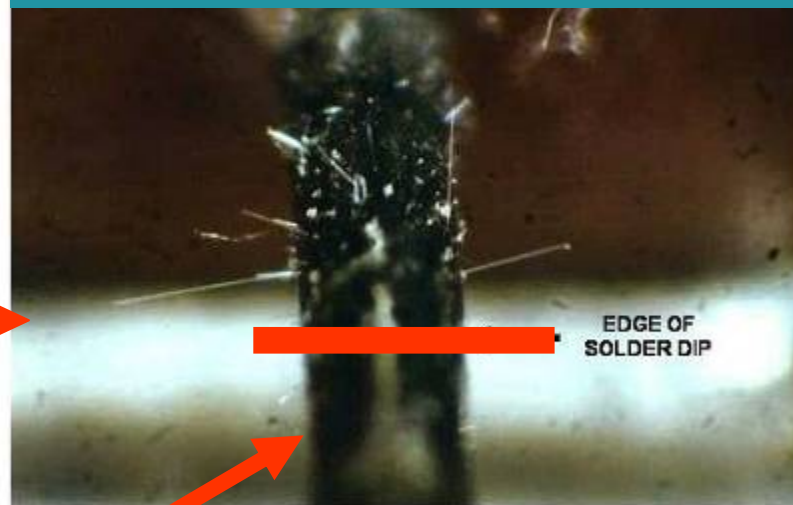
Hot Solder Dip Benefits & Limitations

Field Failure ONE Year After Assembly

**Crystal with Tin-Plated Kovar Leads
(with Nickel Underplate)**

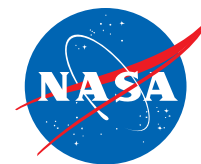


**Tin Whiskers (~60 mils) Grew on
NON-Dipped Region Shorting to Case
Causing Crystal to Malfunction**



- Leads were Hot Solder Dipped (Sn63Pb37) within 50 mils of Glass Seal BEFORE Mounting to enhance solderability
- Dip was not 100% of leads due to concerns of inducing harm to glass seal

- No Whiskers on Hot Solder Dipped Surface
- ABUNDANT whiskers on the Non-Dipped Surface



Optical Inspection for Metal Whiskers

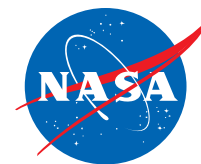
- Basic Equipment:
 - Binocular Microscope
 - Light Source: Flex Lighting PREFERRED over Ring Lamp
- Freedom to tilt sample and/or lighting to illuminate whisker facets is VERY IMPORTANT



June 19, 2008

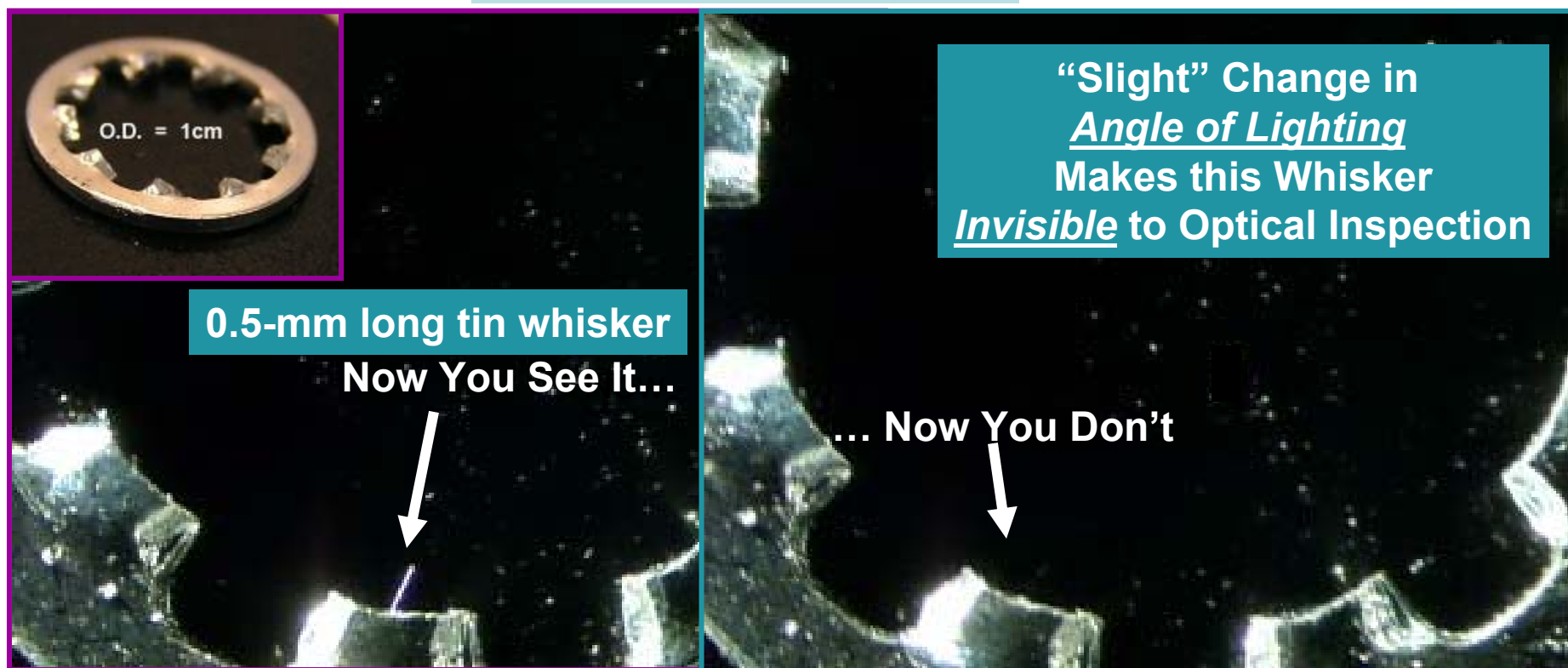
Metal Whiskers

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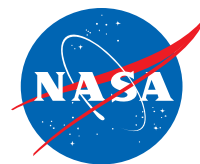


Evidence of “Absence of Whiskers”? (Optical Microscopy)

Tin-Plated Lock Washer



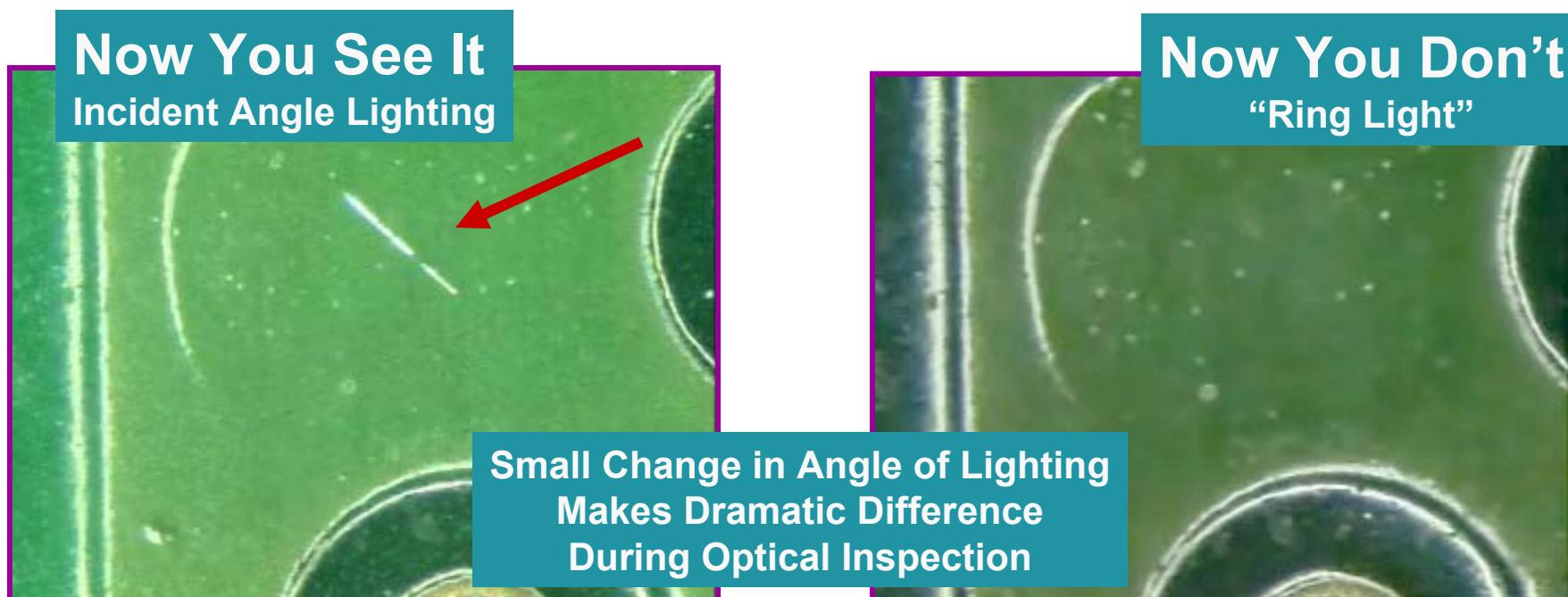
The absence of evidence is NOT evidence of absence

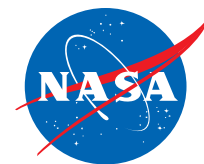


Field Technicians and Failure Analysts Need To Be Acquainted with Metal Whiskers!!!

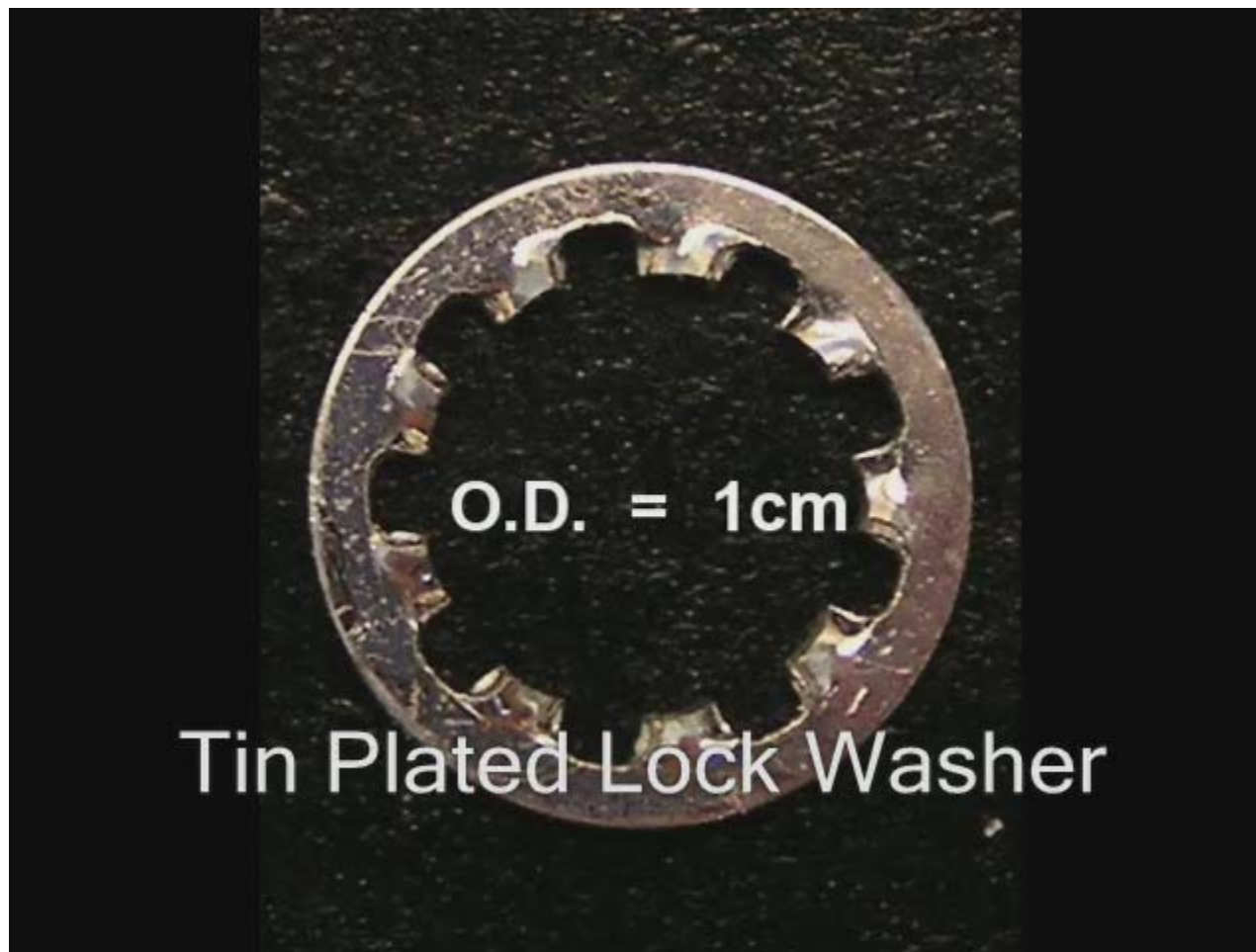
NASA GSFC has published videos to aid in optical inspection for metal whiskers

<http://nepp.nasa.gov/whisker/video>

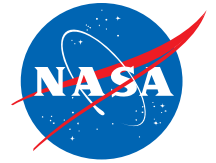




Video Demonstration Optical Inspection For Metal Whiskers (Click Image to Start Video)



Contact Information



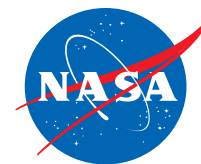
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Work Performed in Support of the
NASA Electronic Parts and Packaging (NEPP) Program

Acknowledgment to Dr. Michael Osterman
University of MD – Center for Advanced Life Cycle Engineering (CALCE)

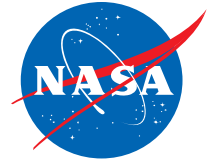
NASA Tin and Other Metal Whisker WWW Site

<http://nepp.nasa.gov/whisker>



Backup Slides

Why Are Tin, Zinc, Cadmium Still Used?

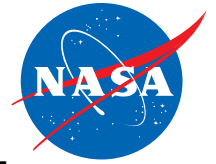


- Not all Tin (or Zinc or Cadmium) surfaces grow whiskers!
 - Rough estimate: 3% to 30% do whisker.
- Not all metal whiskers cause shorts
 - Application matters: geometry, electrical potentials, circuit sensitivity to shorting
 - Rough estimate: 3% to 30% do short.
- Not all whisker-induced shorts are traced to whiskers
 - They are very hard to see and failure analysis techniques often destroy evidence
 - Rough estimate: 0% to 10% are correctly traced.
- Not all identified whisker adventures are reported
 - Rough estimate: 0% to 3% are reported, once identified
- Hence, we expect between 0.00% and 0.03% of shorting problems caused by these coatings to be reported
 - While some 0.1% to 10% of these coatings are actually causing shorts.
 - With such a few public cases, many say “What, me worry?”
- Whiskering is dramatically inhibited when 0.5% (or more) lead (Pb) is added to Tin coatings: the shorting rate then approaches zero
 - This has been the case for the Hi-Rel community
 - But Pb use is being restricted by international legislation, and so the shorting rate may jump to 10% from zero ==> **SWATCH GROUP** <==

"The Five Stages of Metal Whisker Grief"

By Henning Leidecker

Adapted from Elisabeth Kubler-Ross in her book "On Death and Dying",
Macmillan Publishing Company, 1969



Denial

"Metal whiskers?!? We ain't got no stinkin' whiskers! I don't even think metal whiskers exist! I KNOW we don't have any!"

Anger

"You say we got whiskers, I rip your \$%#@ lungs out! Who put them there --- I'll murderize him! I'll tear him into pieces so small, they'll fit under one of those *^&\$#% whiskers!"

Bargaining

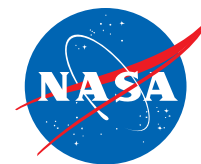
"We have metal whiskers? But they are so small. And you have only seen a few of them. How could a few small things possibly be a problem to our power supplies and equipment? These few whiskers should be easy to clean up."

Depression

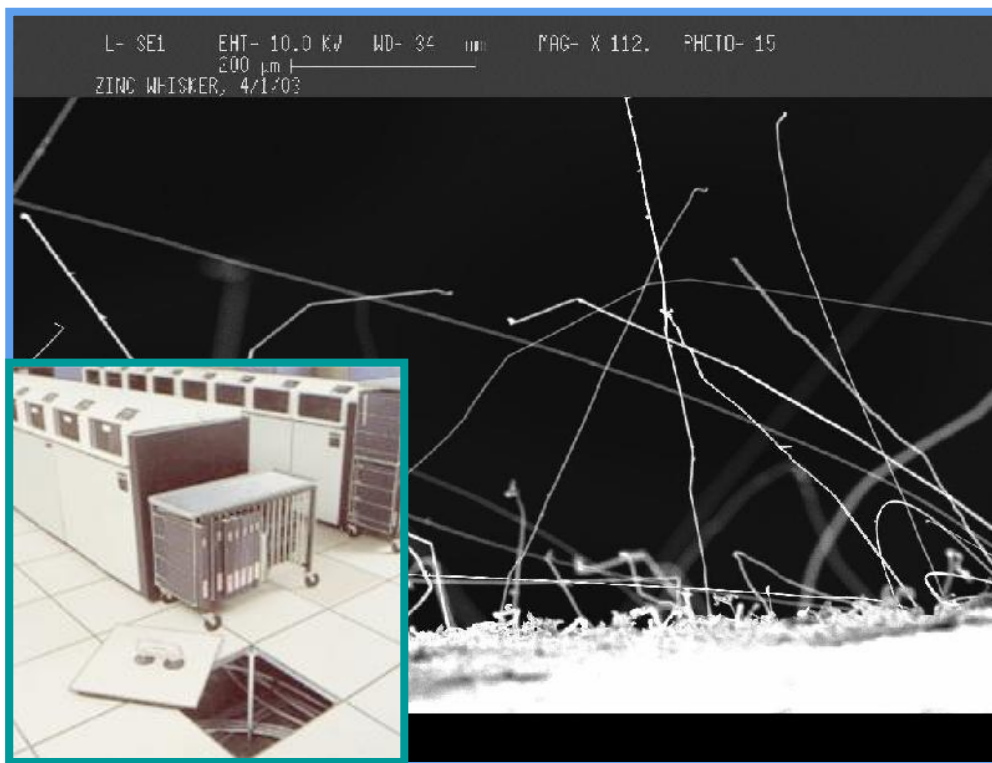
"Dang. Doomed. Close the shop --- we are out of business. Of all the miserable bit joints in all the world, metal whiskers had to come into mine... I'm retiring from here... Going to open a 'Squat & Gobble' on the Keys. "

Acceptance

"Metal whiskers. How about that? Who knew? Well, clean what you can. Put in the particle filters, and schedule periodic checks of what the debris collectors find. Ensure that all the warrantees and service plans are up to date. On with life."



Examples of Metal Whiskers



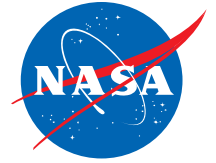
***Zinc-Coated Computer Room Floor Tiles
Zinc Whiskers***

***Cadmium-Plated Connector Shell
Cadmium Whiskers***



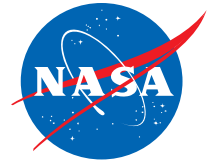
A Few Recent Whisker Experiences:

It's Not Just Tin Whiskers!!!

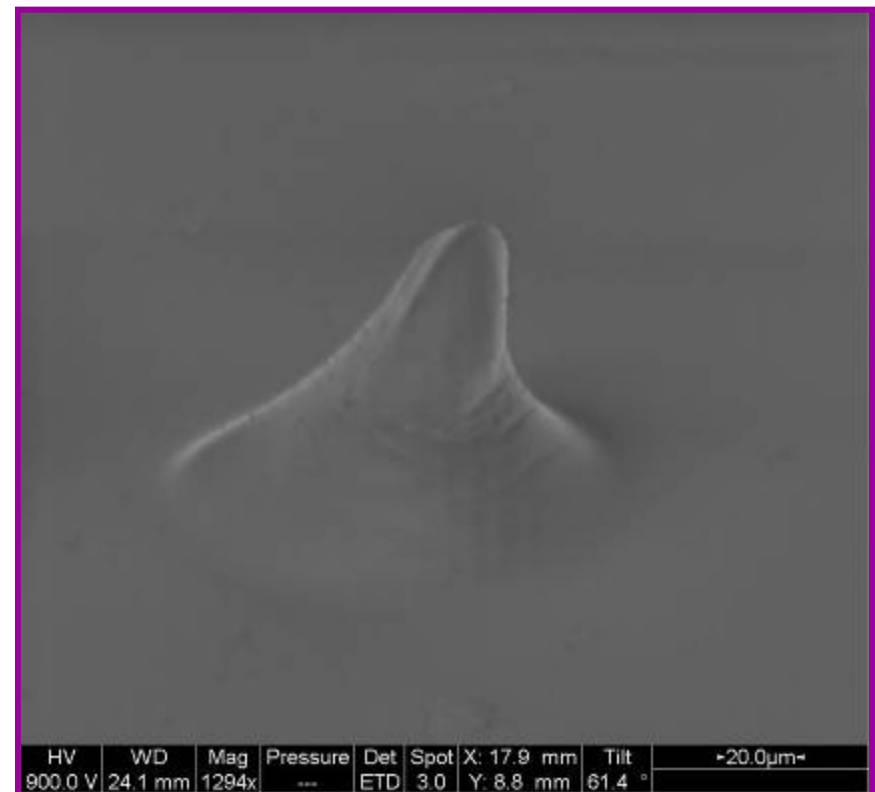
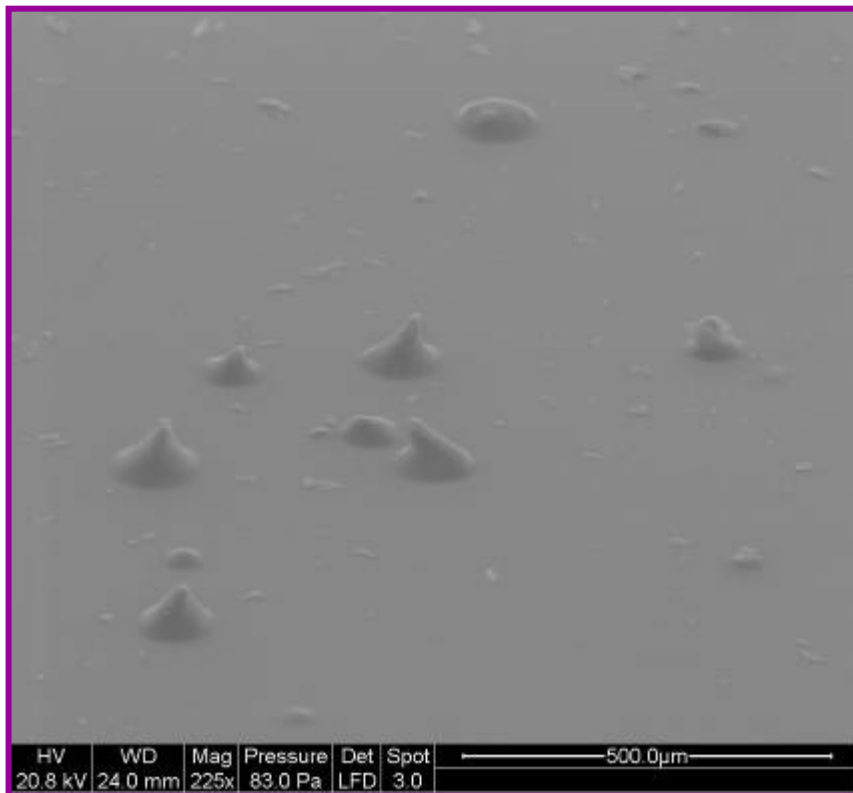


- **Tin Whiskers:**
 - **2005:** Tin Whiskers on diode leads shut down Millstone Nuclear Power Plant
 - **2006:** Tin whiskers on card rails discovered in Space Shuttle Transportation System
Some 100 to 300 million whiskers were in OV-105's boxes
 - **2006:** Tin whiskers on watch crystals reported by SWATCH Group. 30% of new RoHS-compliant Sn-Cu solder sprouting whiskers. 5% catastrophically shorted within months.
- **Zinc Whiskers:**
 - **2005:** Zinc whiskers on raised floor tiles cripple Colorado State Government data center. Forced to build a new “disaster recovery center”
 - **2005:** Zinc whiskers on raised floor tiles destroy 75% of the computer equipment in a particular data center. Investigation takes ~8 months to properly identify root cause
 - **2006:** Zinc whiskers identified as root cause of persistent NAVY weapon system failures
- **Cadmium Whiskers:**
 - **2006:** Cadmium whiskers found on electrical switch proposed for spaceflight program
 - **2007:** Cadmium whiskers on connector shells cause failure during T-Vac testing

Tin Whiskers Forming “Circus Tents” in Thin Uralane 5750 Conformal Coat - 9-Years of Office Ambient Storage

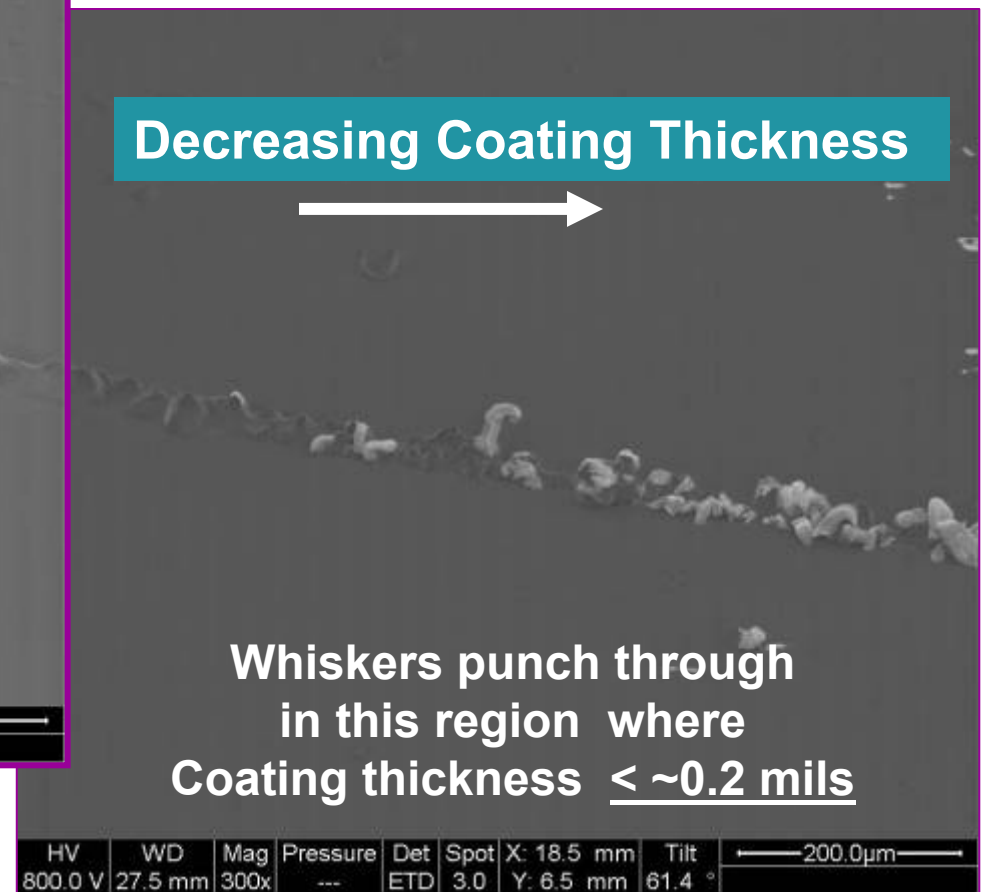
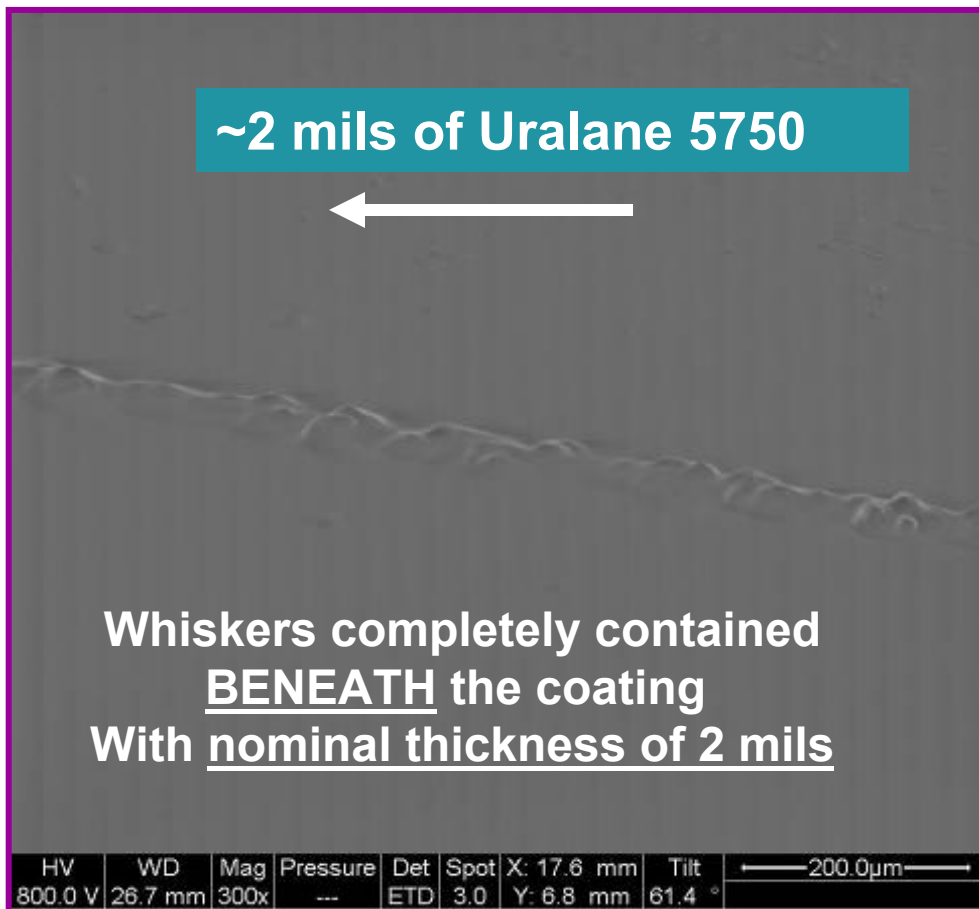
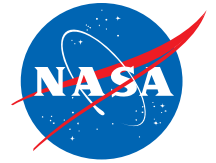


Coating Thickness < 0.5 Mil

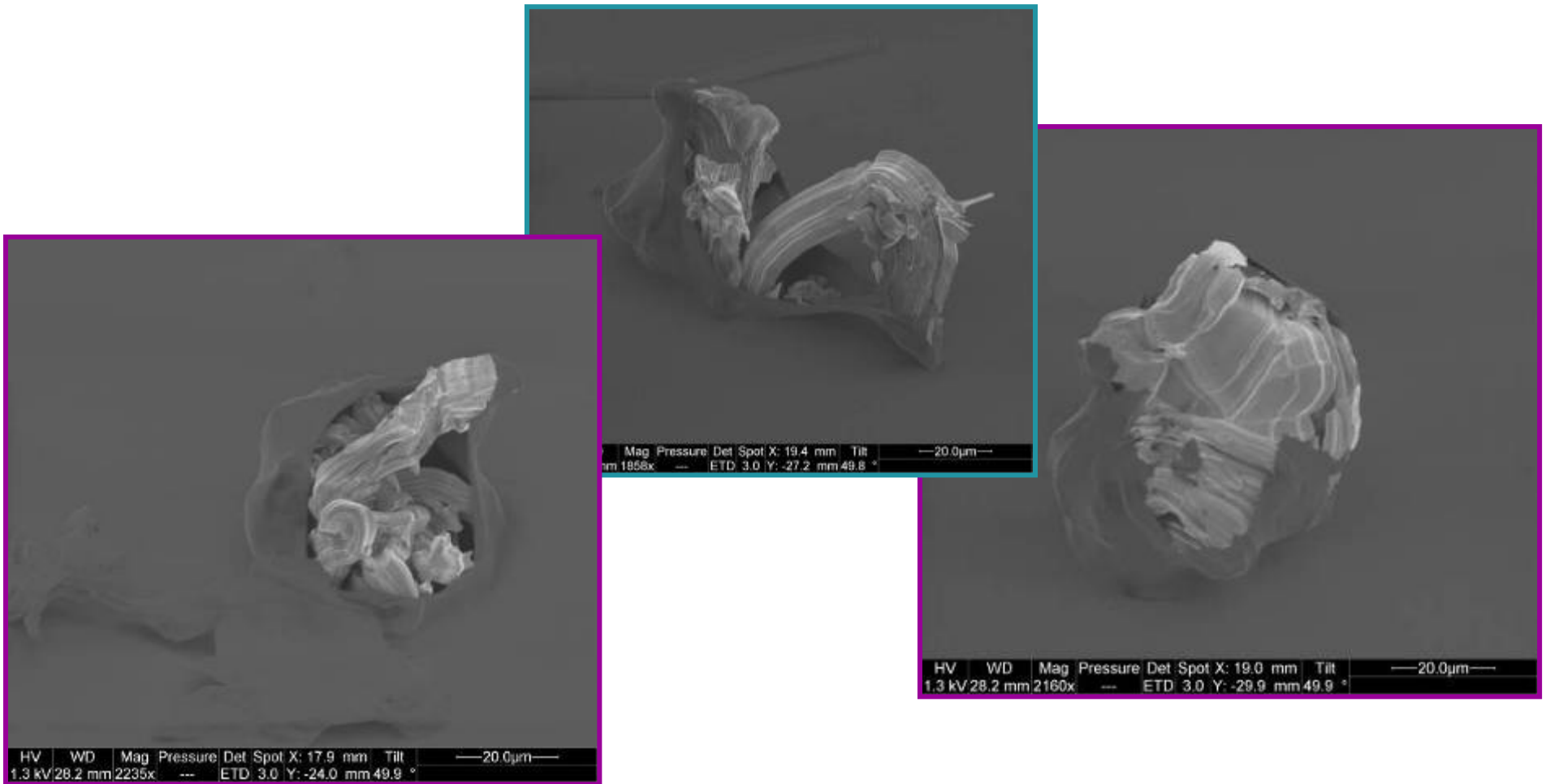
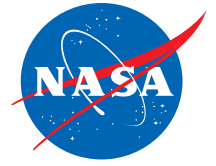


NASA Goddard Whisker Mitigation Study

Whisker Puncture vs. Coating Thickness



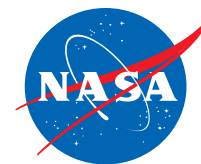
Tin Whiskers Rupturing THIN Coating ***~0.1 to 0.2 Mils Uralane 5750 Conformal Coat*** **9-Years of Office Ambient Storage**



June 19, 2008

Metal Whiskers

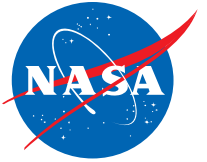
45



Thank Goodness for Euler Buckling and Conformal Coat on this PWB!!!

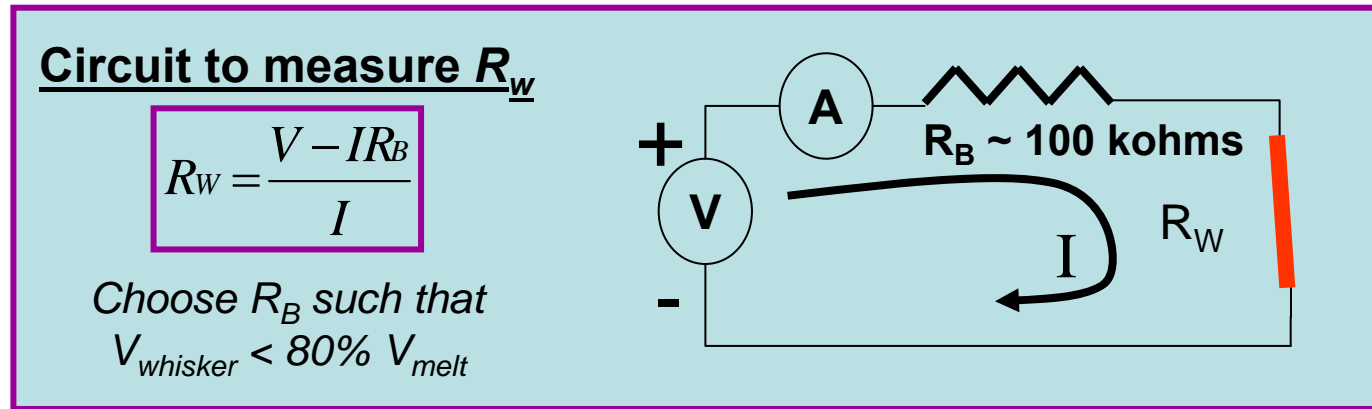


Photo Credit: M&P Failure Analysis Laboratory
The Boeing Company Logistics Depot



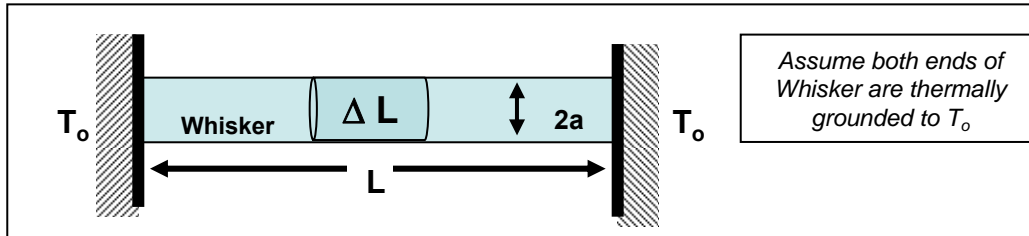
Circuit to Measure Resistance of a Metal Whisker

- Use of a simple “Ohmmeter” to measure the resistance of a metal whisker is NOT preferred
 - Ohmmeter may supply $V_{out} < V_{breakdown}$ for the insulating films (oxides, moisture) that form on a metal whisker
 - Ohmmeter may supply $V_{out} > V_{melt}$ causing the whisker to melt before resistance can be measured
- Instead, a variable power supply and a ballast resistor should be used to overcome the above complications
 - Adjust $V_{out} > V_{breakdown}$ of insulating films on whisker
 - When $V_{out} > V_{breakdown}$, R_B quickly drops $V_{whisker} < V_{melt}$





Derivation of Melting Current of a Metal Whisker in Vacuum



$$\frac{du}{dt} + \Phi = source$$

du/dt

+

Φ

=

source

$$u = C \cdot T \quad c = \frac{C}{V}$$

$$u = \left(\frac{C}{V}\right) \cdot V \cdot T = c \cdot V \cdot T$$

$$u = c \cdot \Delta L \cdot A \cdot T$$

$$\boxed{\frac{du}{dt} = c \cdot \Delta L \cdot A \cdot \frac{\partial T}{\partial t}}$$

Convection loss = 0 for vacuum
Neglect radiation loss

$$\Phi = \left(\frac{\partial J}{\partial x}\right) \cdot \Delta L \cdot A$$

$$J = -k_T \cdot \frac{\partial T}{\partial x} \quad \frac{\partial J}{\partial x} = -k_T \cdot \frac{\partial^2 T}{\partial x^2}$$

$$\Phi = -k_T \cdot \left(\frac{\partial^2 T}{\partial x^2}\right) \cdot \Delta L \cdot A \quad k_T = \frac{Lz \cdot T}{\rho}$$

$$\boxed{\Phi = -\frac{Lz \cdot T}{\rho} \left(\frac{\partial^2 T}{\partial x^2}\right) \cdot \Delta L \cdot A}$$

$$source = I^2 \cdot R$$

$$I = J_e \cdot A \quad R = \frac{\rho \cdot \Delta L}{A}$$

$$source = (J_e^2 \cdot A^2) \cdot \left(\frac{\rho \cdot \Delta L}{A}\right)$$

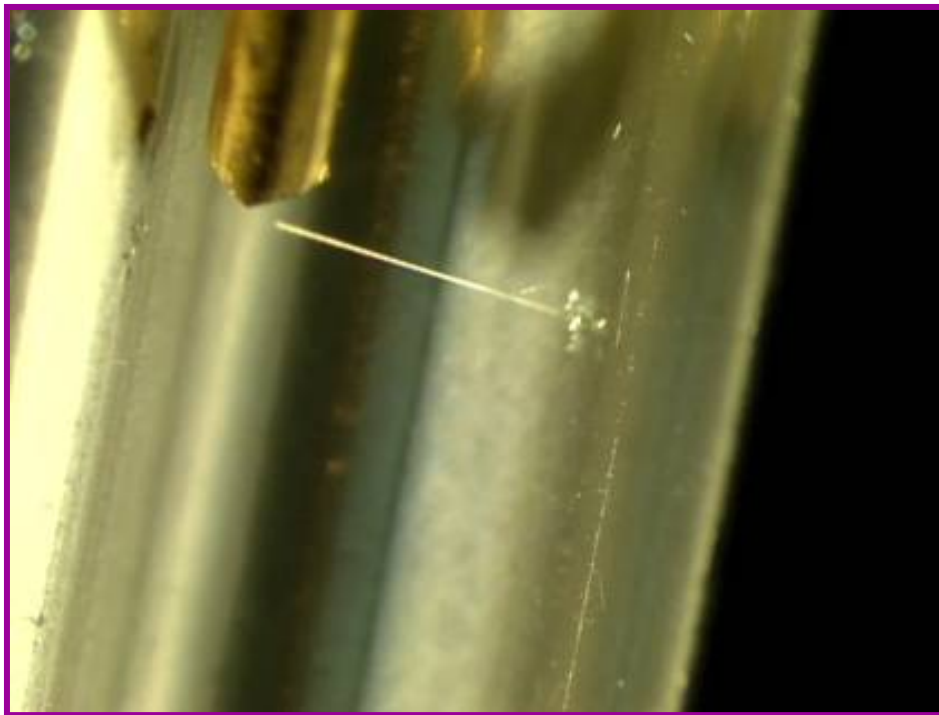
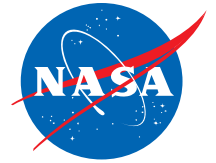
$$\boxed{source = (J_e^2 \cdot A) \cdot \rho \cdot \Delta L}$$

$$\left[c \cdot \Delta L \cdot A \cdot \frac{\partial T}{\partial t} \right] - \left[\frac{Lz \cdot T}{\rho} \left(\frac{\partial^2 T}{\partial x^2}\right) \cdot \Delta L \cdot A \right] = J^2 \cdot \rho \cdot \Delta L \cdot A$$

$$\left[c \cdot \frac{\partial T}{\partial t} \right] - \left[\frac{Lz \cdot T}{\rho} \left(\frac{\partial^2 T}{\partial x^2}\right) \right] = J^2 \cdot \rho$$

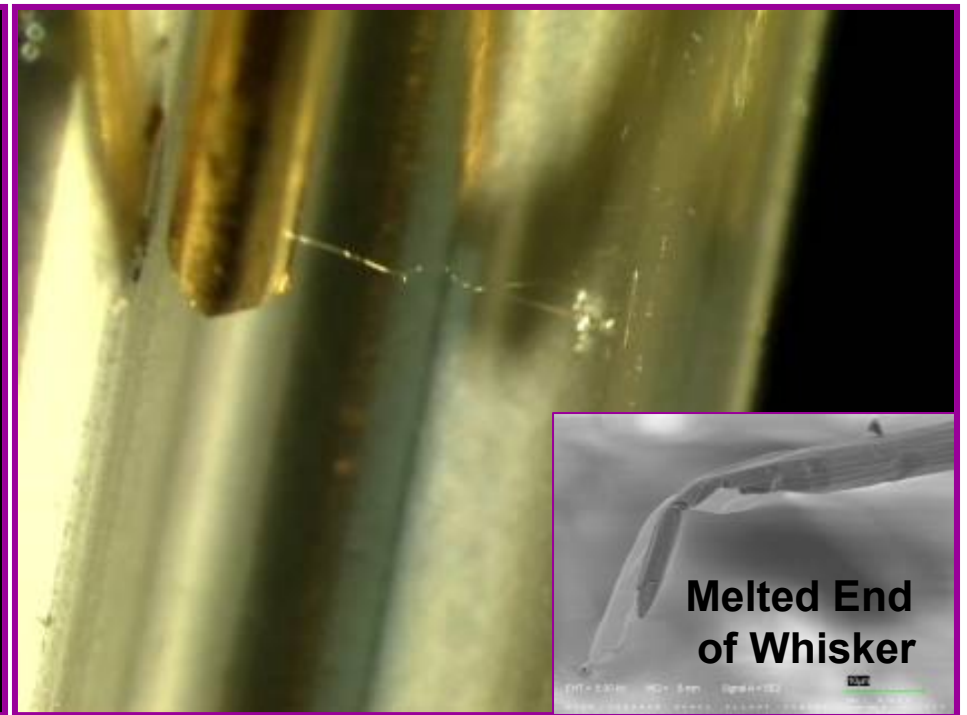
$$I_{melt,vac} = \left[\frac{2\sqrt{LzT_0}}{R_0} \right] \cos^{-1} \left(\frac{T_0}{T_{melt}} \right)$$

An Example of “Melting” a Tin Whisker



Before Contact

1. Gold-Plated Test Probe has +3 Volts Relative to Tin Whisker



After Contact

1. Tip of whisker micro-welds to gold test probe
2. Whisker melts mid-length
3. Small section of whisker root remains attached to substrate